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SURVEY OF ORGANIC SEMICONDUCTORS INCLUDING ELECTRICAL AND MECHANICAL PROPERTIES OF PLASTICS

DR. JOHN H. MEISER

*University of Dayton
Research Institute*

TECHNICAL REPORT AFFDL-TR-68-68

JUNE 1968

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FOREWORD

This report was prepared by the University of Dayton Research Institute, Dayton, Ohio, under Contract AF 33(615)-2674 with the Air Force Flight Dynamics Laboratory, Wright-Patterson Air Force Base, Ohio. This research was performed under Program Element 6. 16. 46. 01. D. in support of Project 1473 Task 147301. Dr. W. A. Kapp (FDTR) was the Air Force Project Monitor. The research reported herein was performed during the period 16 May 1967 through 30 November 1967 and the report was submitted 13 December 1967. Principal investigator was Dr. John H. Meiser, Assistant Professor of Chemistry, University of Dayton.

This technical report has been reviewed and is approved.



FRANCIS J. JANIE, JR.
Chief, Theoretical Mechanics Branch
Structures Division

ABSTRACT

A comprehensive list of organic semiconductors has been prepared to include compounds having resistivities in the range 10^{-3} to 10^{20} ohm cm. Where electrical and mechanical properties were found, they were included. Five classes of compounds were reviewed and ten compounds were suggested as displaying electrical hysteresis effects due to mechanical loading. Included in the tables is a listing of physical properties of commercially available plastics.

TABLE OF CONTENTS

	Page
Introduction	1
Part I	
Concepts and Symbols	2
Compilation Coverage	3
Manner of Presentation	4
Part II	5
Review of Data	5
Compounds Exhibiting Hysteresis	6
Polymers	7
Part III	11
Tables	
Table 1	
Metal-Free Molecular Crystals	12
Table 2	
Complex Metal Compounds	24
Table 3	
Charge Transfer Complexes	28
Table 4	
Free Radicals and Radical Salts	43
Table 5	
Polyacenequinone Radical Polymers	50
Table 6	
Long Chain Compounds and Polymers	60
Table 7	
Organic Dyes	74

Table of Contents, continued

Table 8	
Biological Materials	78
Table 9	
Liquids and Glasses	84
Table 10	
Physical Properties of Commercially Available Plastics	87
Table 11	
Physical Properties of Plastics Used Primarily as Films	
Not Listed in Table 10	130
A.S.T.M. Test Methods for Physical Properties Appearing	
in Table	133
References	135

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INTRODUCTION

The following report was designed as a literature survey of organic semiconductors and as a compilation of their electrical, mechanical, and chemical properties. Included in the report are commercially available plastics whose resistivities place them near the low end of compounds considered as semiconductors.

This report is divided into two sections: Part I is a listing of the above properties, and Part II is a discussion of these properties with regard to electrical hysteresis due to mechanical loading.

PART I Review of Published Data

In terms of conductance, an organic semiconductor is found normally with a conductivity (ohm cm)⁻¹ between 10² and 10⁻¹⁴. Its carrier concentration, either p-type or n-type, will typically be in the range of 10⁶ to 10¹⁹ carriers per cm³. The mobility, μ (a measure of the ease with which the carriers pass from one molecule to the next), will be found between 10² and 10⁻⁶ cm² volt⁻¹ sec⁻¹. The above quantities, when compared to values for a typical metal, are found to be 10² to 10⁸ (ohm cm)⁻¹, 10²² carriers per cm³, and 10³ cm² volt⁻¹ sec⁻¹, respectively. Thus, we have the distinction between organic semiconductors and metals and a general idea of their relationships with regard to these quantities.

However, Pohl¹⁴⁰ states that a substance should show six properties in order to be listed as an organic semiconductor:

- (1) Conductivity in the range 10⁺⁴ to 10⁻¹² (ohm cm)⁻¹;
- (2) Negative temperature coefficient of resistance;
- (3) Conductivity sensitive to impurity concentrations;
- (4) Usually a high thermo-electric power;
- (5) Rectification or at least non-ohmic behavior at junctions;
- (6) Photo-sensitivity.

Unfortunately, many of the compounds of interest to us have not been studied enough to yield sufficient data to allow their classification according to Pohl's definition - particularly with regard to the last five properties. Therefore, we will list all compounds as semiconductors when their conductivities fall into the above range. For the sake of completeness, many compounds with conductivities down to $10^{-18} \text{ (ohm cm)}^{-1}$ will also be listed.

Concepts and Symbols

The conductivity of substances as appears in the tables obeys an equation of the form

$$\sigma = \sigma_0 e^{(-E/2kT)} \quad (1)$$

over some range of temperature,

where: σ = conductivity, (ohm cm)^{-1}
 σ_0 = constant
 E = energy gap
 T = temperature
 k = Boltzmann's constant.

In general, the exponential factor determines the temperature dependence and arises from the exponential increase in probability that charged carriers are thermally liberated across a potential barrier. But depending on the envisaged mechanism for the liberation, a thermal term can be contributed to σ_0 .

It may be shown¹⁴¹ that an equation for conductivity in the form

$$\sigma = \sigma_0(T) \exp(-E/kT) \quad (2)$$

can give rise to Equ. 1 where $\sigma_0(T)$ represents any function of T , subject to certain conditions. Thus, the experimental value of E may be temperature independent only approximately. Thus, before experimental results can be

theoretically evaluated, an assumption as to the manner of charge transport must be made. Such descriptions are outside the purpose of this survey and the interested reader is directed to the many books which discuss this problem^{77, 142, 143, 145}

The reader is cautioned in comparing the data which appears here and those in the original literature. The energy term for Eqn. 1 often appears in several different forms: $E/2kT$, E/kT , or E/RT . In E/RT , E is expressed in kilocalories per mole and has the numerical value of $\frac{2E}{23}$ electron volts. In our listings, all entries are made to conform to the first expression, $E/2kT$, and are in electron volts.

For convenience, instead of listing conductivity, we will list the specific resistance. This is easily accomplished since

$$\sigma = 1/\rho \quad (3)$$

where ρ is the specific resistance. Then Eqn. 1 can be rewritten as

$$\rho = \rho_0 e^{E/2kT} \quad (4)$$

Thus, the values of ρ and E in the following tables will conform to the above Eqn. 4. Rather than continue a discussion of the various entries here, the meaning of the entries should be clear from the tables.

Compilation Coverage

These tables were obtained by a thorough search of the physics and chemistry literature, including publications in chemical engineering. The search was performed with one computerized search and by manual searching. Manual searching was found to be far more suitable for finding data. This is due in part to the fact that chemical literature has not been thoroughly computerized. The major source searched was Chemical Abstracts. Indeed, cross-checking of references at the end of individual

papers insured also the inclusion of those references if not entered into the Chemical Abstracts. The search includes data published up to June, 1967.

In view of the second part of this paper, a few substances which were found with very high specific resistance (low conductivities) 10^{16} or larger, were eliminated from the tables since they fall far outside the limits set for organic semiconductors. No deletions in the opposite direction (low resistivity) were made.

Manner of Presentation

In order to facilitate the listings, the compounds have been divided into a number of sections following that of Gutmann and Lyons¹⁴². This division depends partially on the substances' nature and partially on the manner of their occurrence. Although there is a section on biological materials, some of these materials may be listed under molecular crystals because they occur in nature as crystals or because of the major work performed on them as molecular crystals.

Each compound as appears in the table is listed in alphabetical order and accompanied by the value of its (room temperature) resistivity, temperature range to which the resistivity is applicable, and the energy gap.

PART II Criticism of Data and Recommendations

Review of the Data

The first thing which we note about the tables in this report is the lack of data. The lack of data present is due to several things. Primary among these is that for most of the compounds listed, engineering data simply do not exist. It was decided to compile, at first, as complete a list of organic semiconductors as possible without regard to their mechanical properties and then to add the mechanical properties as far as available.

Although a value appears for the resistivity of a particular compound, the data cannot be accepted without a critical review of the techniques used to obtain the data. Thus, some authors do not list the methods used in the resistivity determination. Other authors do not take into account space-charge considerations, or the effect of the contacts used in their particular method. Rust and others⁽⁶³⁾ describe some of the dangers involved in using the most simple techniques for contacts and encapsulation of the sample material. It is often found that the temperature or pressure (in compacting samples) is inadequately controlled or not reported. In view of these shortcomings, the tables of data were reported without critical evaluation of the methods used to obtain the data.

Another problem presents itself in the task of collecting data for many of these compounds.

If the above tables are carefully examined and checked with the original literature, it is seen that many of the compounds were first prepared by the researchers reporting the compounds' resistivity. Quite often, the total yield of such reactions is a few tenths of a gram of product. When the investigator did not find the particular effect desired for this investigation, the compound often no longer was investigated. Thus, automatically, one would not expect much data to be available on these compounds. When data

are available, they are included. Thus, commercial plastics have a special table devoted to their physical properties. These data normally are given with a range of values of their physical properties since samples from different commercial suppliers will generally vary.

One will also note that most of the compounds in this table lay outside the resistivity range given by Pohl as appropriate to organic semiconductors. Their inclusion, especially with regard to polymers, was done to present a more complete list of compounds upon which work has been done.

Normally, the procedures for preparing the compounds presented in this survey will be found in the journal article referenced. This is not true for the commercially available plastics whose actual preparation is normally proprietary information.

Compounds Exhibiting Hysteresis

One of the most interesting compounds to come to the attention of this investigation is not even listed as having a determined resistivity in the tables. However, its properties are such that it should be investigated both for possible semiconducting properties and also for resistive or dielectric hysteresis. This organic molecular crystal is thiourea ($\text{CH}_4\text{N}_2\text{S}$). At normal temperature and pressure the crystal belongs to the orthorhombic centrosymmetric group D_{2h}^{16} (P_{nma}) with four molecules in the single crystal. Bridgman⁽²³⁹⁾ investigated the phase diagram for thiourea. Extrapolation of his data gives a transformation at 25°C of 3460 kg/cm^2 . Leonidova⁽²³⁸⁾ found that a first-order transformation occurs in thioruea under a pressure of 4000 kg/cm^2 between 18 and 74°C . Thiourea has ferroelectric properties along the 010 axis at temperatures below 169°K and between $+76$ and 180°K . At all other temperatures between 90 and 300°K the crystal is antiferroelectric and the phase transition involves a change from one state to the other at high pressures. The important thing to our discussion is that ferroelectric

properties of the samples may be measured by a hysteresis loop which forms with a change in pressure. Leonidova⁽²³⁸⁾ also found after 2 - 3 cycles of increase and decrease of pressure, his single crystal of thiourea broke. Single crystals can be grown by evaporating the solvent from a saturated solution of thiourea in methyl alcohol. The thiourea is commercially available. Samples used in the above work were 7 x 5 x 1 mm.

Other compounds have not yet been investigated for possible first-order transitions to be used in the same manner as thiourea. However, two other compounds show hysteresis loops of sufficient size that a change may easily be recorded. Pyranthrone shows a resistivity versus temperature hysteresis. Ferrocene, on the other hand, has a resistivity versus pressure relaxation. In this case the changing parameters appear to be due to a mechanical lengthening and shortening of the intermolecular bands. Ferrocene has a resistivity in the order of 10^7 ohm cm and thermoelectric power + 1.2 - 1.6 mV/deg. It is found that the resistance normally decreases with increasing pressure reaching a minimum at 5000 atm. followed by an increase with increasing pressure. This is a reversible process except for the hysteresis and is not due to polymorphic change. References 231, 229, 230, and 63 are specific papers on ferrocene or related compounds. References 77 and 142 are more general references treating ferrocene.

Polymers

Several classes of polymer compounds should be mentioned at this point. Charge transfer complexes, in general, can be stable and may display hysteresis. However, the whole set of hydrocarbon/halogen complexes seems to be stable only under their vapor pressure. They are sensitive to air and to water and thus appear unsuitable to applications where they are in contact with these substances. The reason this set is mentioned is because of their rather low resistivities.

The second set which should be mentioned is the phthalocyanines in combination with various metals⁽²⁴⁰⁾. There does not appear to be any hysteresis but these compounds do show stability. Their crystalline and electrical properties are similar to anthracene exhibiting low carrier mobilities and high electrical resistivity.

Anion-radicals of tetracyanoquinodimethane normally have crystals which are weak and brittle⁽³³⁾. However, low - and intermediate - conductivity compounds often are relatively easily obtained in the form of single - crystals, while high-conductivity materials come out of solution in the form of small needles. Compounds of the type $M+(TCNQ)^-_{1.5}$ and $M+(TCNQ)^-_2$ on heating dissociate into $M+(TCNQ)^-$ and free TCNQ while compounds of the type $M+(TCNQ)^-$ decompose before melting. This class of compounds does not show hysteresis.

Finally, there exist a large number of condensation products which would normally be considered as polymers in the normal sense of the word. Here again there appears to be few reasons to pick one over any other.

For the sake of argument, I would pick the following one or more from the above sets to begin work upon.

Charge-Transfer Compounds

- (1) Azulene : Tetracyanoethylene $\rho = 4.7 \times 10^{10} \text{ ohm}\cdot\text{cm}$

1 : 1 complex made by dissolving equal molar quantities of azulene and TCNE in ether and slowly evaporate solvent. TCNE is available from Eastman and azulene from Rutgerswerke-AG.
Reference 6.

- (2) Cobaltocene : Chloranil $\rho = 2.05 \times 10^4 \text{ ohm}\cdot\text{cm}$

Press versus ρ data given
Reference 73.

- (3) Dibenzo [c, d] phenothiazine:

2, 3 - dichloro - 5, 6 - dicyano - p - benzoquinone

2:1 $\rho = 17 \text{ ohm}\cdot\text{cm}$

1:1 $\rho = 5 \times 10^3 \text{ ohm}\cdot\text{cm}$

For starting material see: Reference 241.

Reference 2.

- (4) p - Phenylenediamine : Chloranil $\rho \approx 10^6 \text{ ohm}\cdot\text{cm}$

Seebeck coefficient : $1.1 \times 10^{-3} \text{ V/deg.}$

Thermal conductivity : $2.0 \times 10^{-3} \text{ w cm}^{-1} \text{ deg}^{-1}$

Chloranil is available from Eastman.

K&K handles p-phenylenediamine.

Reference 167, 6, 62, 233, 1, 27.

Phthalocyanine

- (1) Cu phthalocyanine $\rho \approx 10^{12} - 10^{13}$

References 41, 81, 142, 144, 77. The last three give many more references.

Anion-Radicals of Tetracyanoquinodimethane

- (1) Diaminodurene (7, 7, 8, 8 - tetracyanoquinodimethane)₂

$\rho = 2 \text{ ohm}\cdot\text{cm}$

Reference 33.

(2) N-methylquinolinium (7,7,8,8-tetracyanoquinodimethane)₂

single crystal $\rho = 0.01 \text{ ohm}\cdot\text{cm}$

compacted $\rho = 2.0\text{--}10.0 \text{ ohm}\cdot\text{cm}$

Reference 33.

Condensation Products

(A) Polyacenequinone Radical Polymers

(1) Anthraquinone, pyromellitic anhydride, Zn Cl_2

3:1:2

$\rho = 2.0 \times 10^4 \text{ ohm}\cdot\text{cm}$

Reference 75.

(2) Pyrene, pyromellitic dianhydride $\rho = 2.58 \times 10^4$

Material is insoluble and infusible - slight
thermoplasticity allows compacting. It is
swellable by acetone.

Reference 25.

(3) Pyrene, p-fluorobenzoic acid, Zn Cl_2 (catalyst)

1:1:1

$\rho = 7.8 \times 10^4 \text{ ohm}\cdot\text{cm}$

Reference 55.

PART III - TABLES

TABLE I

METAL-FREE MOLECULAR CRYSTALS

Substance	ρ ohm·cm	Temp °C	E in 2/kT	Sign of Major- ity Carrier	Ref.
Acenaphthene	10^{14}	60	2.0		63
3-Acetylamino-N-methyl- phthalimide	10^{14}	97	3.46		204
3-Acetylamino-N-penyl- phthalimide	10^{14}	67 to 100 54 to 124	3.46 3.50		204
Anils, substituted	10^{11} to 10^{15}		1.9 to 6.5		176
Acridine, i.e., (2,3-benzo- quinoline)	5.6×10^{17}		5.02 0.66		62, 142, 63, 37
Anthracene					Ref. 63: p vs $1/T$, m. p. 111°C sub. Ref. 270: ionization pot. ≈ 4.04 e. v. Ref. 253: electron affinity (PhCl=1)=12 Ref. 270: ionization pot. ≈ 7.40 e. v. m. p. $2.6.2-4^\circ\text{C}$ Heat of combustion at 20°C Ref. 247: $C_V = 9451.0$ cal/g. $C_P = 9453.2$ cal/g Ref. 244: $C_P = 1,688.5$ kcal/mole Ref. 248: $C_P = 1,689.7$ kcal/mole Ref. 244: $\Delta H_{298} = +27,600$ cal. $\Delta S_{298} = -124.7$ e. w. $\Delta G_{298} = +64,800$ cal. Ref. 248: Heat of sublimation, 22.3 kcal/mole Ref. 249: Lattice energy 24.4 kcal/mole
lab (single crystal)	7×10^{15}		1.66		81
lab (single crystal)	10^{19}	30 to 70	1.94		76
(single crystal)	1.35×10^{14}	80 to 200	1.66		142
(single crystal)	10^{22}	80 to 200	2.7		80
(single crystal)	1 to 3×10^{17}				
	10^{14}	20 to 60	1.5		

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Anthracene, (cont.) (single crystal) (compacted)	> 10^{15}		0.5	+	145
	10^{14} at 200°C	160 to 210	2.92		142
(single crystal) (single crystal)	10^{18} 1.5×10^{11}	80 to 150	1.74 ± 0.6		177
(single crystal)	(Cu) contacts > 1.5×10^{11}			+	178
(compacted)	(Al) contacts 10^{15}	160 to 217	2.92		178
For additional data, see					
Anthanthrene (evaporated) (single crystal)	10^{18} 1.5×10^9 1×10^{13}		1.94		9, 12, 45, 182, 183, 184, 142 265
Anthanthrone	7.7×10^{18}	40 to 150	1.70		191
1, 9, 4, 10-Anthradipyrimidine	8.8×10^{24}	15	3.22		76
Anthranilic acid	2×10^{15}	72	3.38		191
Anthrone	8×10^{14}	91	1.2		12 12
1,2-Benzacridine	10^{17}	30	2.10		Ref. 270: ionization pot. = 7.01 e.v. $\rho_o = 1 \times 10^4$ $\rho_o = 2$ $\rho_o = 10^4$ ohm·cm $\rho_o = 1.3 \times 10^{-3}$ m. p. 146°C $\rho_o = 2.1 \times 10^5$ ohm·cm, discontinuity in ρ at 91°C
2,3-Benzacridine	10^{17}	30	1.66		91
3,4-Benzacridine	10^{15}	30	2.4		204 63 77 77 77

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Majority Carrier	Ref.
Benzanil	1013	20 to 50	5.6		176
1,2-Benzanthracene	1016	30	2.8		77
Benzanthrone	1.6x10 ¹⁶ to 4.3x10 ¹⁵		2.7 to 3.42	m.p. 162°C	70
Benzene	1015	5 to -14	0.84±0.08		142
Benzimidazole	5x10 ³	84 to 144	3.0 to 4.0		191
	1015	84 to 27 25	1.9 to 2.3 3.0-4.0	Ref. 259: dipole moment=4.03 D	194
Benzophenone	1011	12.7	3.34		204
	3x10 ¹³	-7	3.34	m.p. 48.1°C (α) m.p. 26°C (β)	204
Biphenyl	1.7x10 ¹⁵	50	2.92	Photoconductivity activation energy 0.087; m.p. 70°C	77
Carbazole	2.5x10 ¹⁵	50	1.172		79
o-Chloranil	1015		3.0	m.p. 247°C	142
Chloropromazine (single crystal)	1012 at 32° 1015 2.6x10 ¹¹	32 to 80 > 47	2.1 2.0	m.p. 290°C m.p. 59-60°C	186 142 84, 147
Chlorpromazine-free radical				m.p. 59-60°C	84, 187
Circumanthracene (single crystal) (film)	6x10 ² 1016-1017		1.8 1.7		188 188
Coronene	1.7x10 ⁷	15	1.7	m.p. 438-40°C	198
Cyamelumrine	106-109				278
Cyananthrone	1.2x10 ⁷	30 to 125	0.20	$\rho_0 = 10^5$ ohm·cm	191
1,6-Diaminopyrene	108		0.6		278

Substance	ρ ohm·cm	Temp °C	E _{1/2} E/2kT	Sign of Majority Carrier	Ref.
Dibenzofuran	7.75x10 ¹⁴	50	0.890		79
Dibenzothiophene	1.0x10 ¹⁵	50	1.712		79
Dibenzo-(a, h)phrene-7, 14-dione	1x10 ⁴				24
Dibenzo-(cd, jk)pyrene- 6, 12-dione	2x10 ⁴				24
2, 3-dichloro-5, 6-dicyanobenzo- quinone	5x10 ⁸	25	0.6		277
Flavanthrone	1.4x10 ¹¹ 1.25x10 ¹¹	30 to 125 30 to 125	0.70 0.70		191 57
9-Fluorene(fluorenone)	3x10 ¹⁵	50	5.40		63
Fluorescein	10 ¹⁴	84	2.44		204
Fluoridine	6x10 ³ 4x10 ¹⁵ 2.5x10 ¹³	20 to 140 20 to 140 20 to 140	1.6 1. p. 95	+ + +	189 189 189
Hexacene	3.8x10 ¹⁰	50	1.14 to 1.3		12, 79
Hexamethylbenzene	10 ¹⁸	20 to 140	1.78	+	190
Hydroviolanthrene	1.1x10 ²⁵	145 to 227	3.4		191
3-Hydroxy-n-methyl-phthalimide		60 to 91	3.80		142
Imidazole	7x10 ¹¹	30	2.6		194, 286
Indanthrazine	1.4x10 ¹⁵	30 to 125	0.66		191, 57

m.p. 86-7°C
m.p. 332-3°C
 ρ vs pressure
 ρ vs pressure

decomposes: 214-150°C

ref. 191: $\rho = 10^5$ ohm·cm

m.p. 830°C

decomposes: 314-6°C

m.p. 90°C; ref. 259: dipole
moment 3.99 D

$\rho_0 = 2.2 \times 10^9$ ohm·cm

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Indanthrone (black)	7.5x10 ¹⁴ 2.5x10 ⁸ 2.5x10 ⁸	30 to 125 30 to 125	0.64 0.56 0.76		191 191 63
Meso-naphthodanthrene		40 to 450 5 to 110 110 to 250	1.48 0.86 1.46 .74		160 160 267 192
2-Methoxynaphthalene		42 to 58	6.5		
Naphthacene					
	1.2x10 ¹⁴	30	1.70 to 1.64		76 12, 181
Naphthalene					
					Ref. 248: heat of combustion (Cp at 20°C) 2140.86 kcal/mole Ref. 283: 6.95 e.v. ion. pot. Heat of sublimation 29.7 kcal/mole Ref. 41: work function 5.25 m.p. 335°C
					Ref. 249: lattice energy 17.3 kcal/mole m.p. 80.22°C Ref. 253: electron affinity (PhCl=1) = 0.01 Ref. 270 & 294: Ionization pot. = 8.08 e.v.; ref. 283: 7.53 e.v. Ref. 244: S ₂₉₈ =39.9 e.w. ΔH ₂₉₈ =15,960 cal. ΔS ₂₉₈ = -98.0 e.w. ΔG ₂₉₈ =+45,20 cal.
	10 ¹⁵ 10 ¹⁹ 10 ¹⁵ 10 ¹⁵ 10 ¹⁴ 10 ¹⁴	60 to 75 20 to 75 40 to 72 40 to 80 25 to 70 27 to 47	3.7 1.4 3.0 1.46 1.5 3.5 2.25		193 83 194 83, 195 176 142 265

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Naphthalene-picrate		48 to 96	2.2 to 2.6	m.p. 151.5°C	192
m-Naphthodanthrene	4×10^8	40 to 150	1.20		191
m-Naphthodanthrone	1.5×10^{18}	40 to 150	1.30	$\rho_0 = 6 \times 10^6$ ohm·cm	191
meso-o-naphthodanthrone			0.74 & 0.43		267
β -Naphthol	2×10^5	60 to 110	$2.36 \pm .01$	m.p. 122°C	90, 58
1-Naphthylamine	$10^{10} - 10^{13}$	25 to 42 20	2.2 to 2.9 1.8 to 2.8	m.p. 50°C $\rho_0 = 5.6 \times 10^{-14}$ ohm·cm 7.6×10^{-8} ohm·cm	192 273
1-Naphthylamine picrate		28 to 98	2.7 to 2.9		192
2-Naphthylphenylsulfone		67 to 102	3.5 to 3.8		192
1-Nitronaphthalene		25 to 44	2.5 ± 0.1	m.p. 58.5°C	192
Octahydroviolanthrene	1.1×10^{25}		3.4		191
Octoldo-p-benzquinhydrone	10^{11}				62
Ovalene	2.3×10^{15} 2.3×10^{15}	40 to 125	1.14 1.13		191, 93 144, 180, 12, 196
Pentacene	1×10^{14}		1.5	Ref. 41: workfunction 5.1 m.p. high; b.p. 290-300°C sub. Ref. 76: $\sigma = 10^{-2}$ ohm $^{-1}$ cm $^{-1}$	77, 144 24, 76 265
	6×10^{13}	0 to 150 20 to 140	1.62 1.5 1.5	Unit cell a(7.90, 101.3); b(6.06, 111.8); c(15.95, 94.4)	79, 41
Perylene	4×10^8 1017 1×10^{18}	15 60 to 80	2.0 1.96 2.0	m.p. 273-4°C $\rho_0 = 1$ Ref. 270: Ionization pot. = 7.06 e.v.	198 76 142

Substance	ρ ohm-cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Perylene (continued)					
	10 ¹⁸	80 to 180	2.0		198, 93
(single crystal)	~10 ¹³	50 to 130	2.2		198, 93
(single crystal)	6.5x10 ¹⁵	40 to 100	↓(001)2.1		197, 77
	4.1x10 ¹³	40 to 100	↓(001)2.2		197, 77
			1.80		265
Phenanthrene	10 ¹³	27 to 90	2.82		142
				Ref. 3: electron affinity ~ -1.3	
(single crystal)	4.8x10 ¹⁵	12 to 72	↓(ab)1.14		200
(single crystal)	1.3x10 ¹⁴	12 to 72	↓(ab)1.15		200
(single crystal)	5.4x10 ¹³				199
				Ref. 244: $\Delta H_{298} = +23,100$ cal	
				$\Delta S_{298} = -123.7$ e.v.	
				$\Delta G_{298} = +60.0$ kcal	
See also:					3, 63,
					201,
					202
(compacted)			2.24		265
				Shows phase transition at 64-71°C	
				Ref. 248: heat of combustion	298
				(Cvat 20°C) 1,684.88 kcal/g	
Phenazine	7x10 ¹⁴	100	2.1		37, 203
				m.p. 171°C	
				Ref. 37: thermal activation energy	7
				at illuminated electrode	142
				0.17(-), 0.11(+)	
1-Phenyl-naphthalene	1.7x10 ¹¹				235
Phenosafranine	10 ¹²	84	2.08		204
				m.p. ca. 45°C	
				T vs σ, λ corresponding to E	
				is 595 m μ	
Phenothiazine	10 ¹¹	50 to 150	1.6		
				Ref. 270: ionization pot. = 7.28 e.v.;	
				m.p. 185.5°C	68, 203

Substance	ρ ohm-cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	T vs σ , λ corresponding to E is 375m μ	Ref.
Phenylanthranilic acid	2×10^{15}	87 to 119	3.30			204, 260
Phosphonitric chloride trimer	$> 10^{15}$ 10^{15} 8×10^{10}		1.68 0.7			142 142 205
Phthalocyanine, metal free	10^{13}	26 to 350	1.66	-	Mobility 0.1 to 0.4 cm ² /V.sec Ref. 254: μ_K in H ₂ SO ₄ = 1.65 ± 0.02 Mobility 4×10^{-3} cm ² /V.sec Does not melt	207 206 142 142
	10^{12} to 10^{13}	60 to 110	1.7 $\pm$.1 1.74	+	See ref. 142 for more references	208 261
Phthalocyanine (metal-free α)	2×10^4 4×10^5	25 -60 to 135	1.385 0.48		Seebeck coef. :-1.68mV/°C	285 209
(metal-free β)	2×10^{15}	200 to 315	1.82			209
(metal-free α)	2×10^{11}	20 to 100	1.32	+		142
(metal-free β)	5×10^{12}	25 to 165	0.81 1.66	+	Mobility 0.1 to 0.4 cm ² /V.sec	207, 42
(single crystal) (metal-free β)	3.6×10^{17}	60 to 200	(b) 1.82			210
Pinocyanol	10^{12}		1.8		at 10^{-4} to 10^{-5} mm press.	219
Pyranthrene	1×10^{15} 4.5×10^{16}	15	1.11 1.71		$\rho_0 = 2 \times 10^7$	12 57, 12, 145, 77
Pyranthrone	$3 \times 9 \times 10^{15}$	40 to 150	1.06; 1.8		m.p.: d. sub. vac. $\rho_0 = 3.7 \times 10^6$ ref. 56; 1.3×10^{-1} ref. 63	56 63

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Pyranthrone (continued)			1.5±0.05		
	10 ²⁰ 5x10 ¹⁷	60 to 90	2.4 2.02		See 24 for pressure effects no hysteresis with pressure E activation of photocurrent = 0.18 e.v. Electron affinity +0.8 Ionization potential 7.4 eV ref. 74, 283 Ref. 181: 3.6x10 ⁻² photocurrent 3, 12, 15, 22 76
	10 ¹⁸		2.02		$\rho_o = 1$ ohm·cm, $I_{E_1} = 3.70$ Ref. 247: heat of combustion Cv at 25°, 9260.1 cal/g Ref. 249: lattice energy 22.5 kcal/mole Ref. 255: relative electron absorption coef. (PhCl=1)=6.0 m.p. 159-50°C
5,6-N-pyridine-1,9- benzanthrone	8.5x10 ²²	15	3.20		$\rho_o = 1.4 \times 10^{-5}$ ohm·cm 191, 77 144
p-Quaterphenyl	1.0x10 ¹⁵		1.78		photoconduction thermal activation energy 0.12±0.015 eV m.p. 118°C 37, 77
Quaterylene (single crystal)	10 ⁵ ab 10 ¹³ ab		0.6	-	Mobility 10 ⁻³ cm ² /V·sec Does not melt or decompose at 500°C 91, 272
Quinhydrone	10 ¹¹				m.p. 171°C 62
α -Resoicln	2x10 ¹⁶	30 to 94	2.10		

Substance	ρ ohm.cm	Temp oC	E in E/2kT	Sign of Major- ity Carrier	Ref.
β -Resoicln	2x10 ¹⁸ 5x10 ¹⁸	30 to 94 56 to 98	3.27 4.24		142 142
Salanil	10 ⁴	20 to 40	4.1		92
Salen	10 ¹¹		5.7		92
Salphen	10 ⁹		5.4		92
Stilbene	5x10 ¹¹		1.70	+	45, 176
<u>cis</u> - Stilbene					3
					Electron affinity ~0.0 Ref. 253:(PhCl= 1)=1.0
<u>trans</u> - Stilbene		70 to 120	2.4		m.p. 124°C Electron affinity ~+0.5 Ref. 253: 4.0
					3, 77
m-Terphenyl				+	142
p-Terphenyl (single crystal)	10 ¹⁴ 5x10 ¹⁴	25 50	1.2 2.12	+	37, 77 45, 142
Tetracene	8x10 ⁹ 10 ¹⁵ 3.2x10 ¹² 3.2x10 ¹²	 15 50 50	 1.70 1.32 1.38 1.38	+	24 Compressed at 100 kbar Ref. 23: a 7.98; b 6.14; c 13.57
					a 98.0; β 112.4; γ 92.5 See also: 76, 77
Tetracyanoethylene	10 ¹²	150			159
1,1,10,10 Tetracyandecapenta- ene	10 ¹³	> 68	2.24		180
1,1,6,6-Tetracyanhexatriene	10 ¹⁴		1.54		180

Substance	ρ ohm-cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
1,1,8,8-Tetracyanotetraene	10 ¹²		1.42	-	180
1,2,4,5-Tetraiodimidazole	10 ⁶				105
Tetrathiotetracene	10 ⁴		0.46		67
Thionine	10 ¹³ -10 ¹¹	49 to 97	1.83		204
Thiphenodioxazine	5x10 ¹⁴ 2x10 ¹⁶ 10 ¹⁵ -10 ¹⁶	20 to 140 20 to 140 20 to 140	1.65 1.7 1.7		142 142 142
2,4,7-Trinitrofluonone	10 ⁹ to 10 ¹²				58
Violanthrene	2.1x10 ¹⁴ 10 ¹⁴ 2.1x10 ¹⁴ 10 ¹⁴ 10 ⁹	40 to 105 60 to 80 80 to 180 50 to 130	0.86 0.9 0.85 0.9 0.9		12 57,93 198 198 198
Violanthrone	2,3x10 ¹⁰ 5x10 ⁹	40 to 150	0.79		56,24
				No hysteresis of ρ with T m.p. 490-5°C d. Ref. 24 gives ρ vs pressure $\rho_0 = 2.9 \times 10^3$ $\rho_0 = 20$ ohm-cm	57 144 29
Isoviolanthrene	3.6x10 ¹⁴ 8.4x10 ¹³		1.92 0.86 to 1.62		
Isoviolanthrone	5.7x10 ⁹ 5.7x10 ⁹ 8.5x10 ⁹ 3.2x10 ¹⁹	40 to 150 50 to 130	0.75 0.76 0.96 1.76		56 93,142 82 70

TABLE 2

COMPLEX METAL COMPOUNDS

Substance	ρ ohm-cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Co-dipyrrromethene-1	1.4×10^{11}	> 159	1.88		173
Cu-dipyrrromethene-1	1.0×10^{11}	> 112	1.85		173
Co-dipyrrromethene-2	2.51×10^{11}	> 100	2.30		173
Cu-dipyrrromethene-2	2.81×10^{11}	> 100	2.33		173
Ni-dipyrrromethene-2	4.47×10^{11}	> 100	2.29		173
Zn-dipyrrromethene-1	1.05×10^{14}	> 152	2.24		173
Dipyrrromethene-1-hydrobromide	4.36×10^{13}	> 142	2.27		173
Ferrocene (single crystal)	1.2×10^{13}	20 to 80	0.6	+	142
	10^{13}	150			159
	8.6×10^6				231, 230
	1.78×10^7				239
	6.4×10^{12} to 2.56×10^{13}				296
Co-phthalocyanine (single crystal) 4×10^9				+	142
Cu-phthalocyanine	10^{12} to 10^{13}	-100 to 200	1.7 2.4	+	142
	10^{12} to 10^{13}	60 to 160	1.7 ± 0.1		261
	2×10^{11}				142
	10^{12}	5 to 85	1.3		174
(single crystal)	10^{12} - 10^{13}	25 to 150	> 370°K 1.66 < 370°K 2.0		142, 271
			- 300°K + > 370°K		175
					175

Mobility: $1 \text{ cm}^2/\text{V}\cdot\text{sec}$
Ref. 63: $P_0 = .65$, $E = 1.56 \text{ eV}$

1 atm
33,000 atm

Mobility: $1.2 \text{ cm}^2/\text{V}\cdot\text{sec}$
Thermoelec. power $1.2 \mu\text{V}$

Mobility: $2.2 \times 10^{-2} \text{ cm}^2/\text{V}\cdot\text{sec}$
Ref. 77: $E = 1.6 \text{ eV}$

Ref. 41: work function 5.0

Ref. 254: pK in $\text{H}_2\text{SO}_4 = 1.64 \pm 0.03$

Mobility $= 75 \text{ cm}^2/\text{V}\cdot\text{sec}$
See also 41, 77, 81, 144

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier		Ref.
Fe-phthalocyanine	4×10^9				Work function 4.85	41
Fe-tetracyanoethylene	3.3×10^8				Dielec. const. $E=7$ at 3000 cycles/sec	268
Mg-phthalocyanine	10^9 to 10^{10}	60 to 180	0.5 to 0.8 1.56		Work function 4.75	41, 77 261
Mn-phthalocyanine (single crystal)	4×10^6					174
Mo-phthalocvanine	$\sim 2 \times 10^9$		1.1		$\rho_0 = 20$, ρ vs T given	63
Ni-phthalocyanine (single crystal)	6×10^{10}				Ref. 77: $E=1.6$ eV	174
Pt-phthalocyanine			3.52		$\rho_0 = 4.4 \times 10^3$ ohm·cm	77
Zn-phthalocyanine (single crystal)	10^{12} to 10^{13} 10^{12} to 10^{13} 3×10^9	-100 to 200 60 to 150	1.8 ± 0.1 1.8 ± 0.1	+	Ref. 254: pK in $H_2SO_4 = 2.31 \pm 0.04$	142 142 174
Ni (2) - Salen	10^{14}		2.1			92
Cu (2) - Salen	$> 10^{15}$					92
Ni (2) - Salphen	10^{15}		3.4			92
Cu (2) - Salphen	$> 10^{15}$					92
Sulfur compounds of aromatic hydrocarbons (structure unknown)	10^2 to 10^4	below 450	0.2			93
Cu-tetra-2, 3-pyridinoporphyrazine	2.9×10^{10} 3×10^7	5 to 100	1.7 0.81 0.81		Ref. 271: $E=1.17$ eV	142
Tri-p-methoxyphenylmethyl- perchlorate (single crystal)	3.5×10^9	18.5		-		142

Substance	ρ ohm-cm	Temp °C	E in E/2kT	Major- ity Carrier	Ref.
Cs-1,3,6,8-tetrabromopyrene	1.6				109
Cs-1,3,6,8-tetrachloropyrene	8				109
Cs-1,3,6,8-tetracyanopyrene	6×10^5				109
Cs-1,3,6,8-tetranitropyrene	2×10^6				109
Cs-pyrene	2.1×10^6				109

TABLE 3

CHARGE TRANSFER COMPLEXES

Donor/Acceptor	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Acenaphthene/tetracyano- ethylene	5.3×10^{13}	20 to 85	2.04		66
Acridine/I ₂	10^{13}				62
Al-diethylchloride/pyridine	5×10^2				299
p-Aminodiphenylamine/ chloranil	10^{10}				62
Aniline/1, 3, 5-trinitrobenzene	1×10^{17}		2.54		113
p-Anisidine/chloranil	10^{11}				62
Anthracene/tetracyanoethylene	1.1×10^{10}	20 to 85	1.34		66
Anthracene/I ₂ vapor	10^{15-16}				142
Azulene/tetracyanoethylene	4.7×10^{10}	20 to 80	0.76		6, 66
Benzidine/I ₂ (1:1)	2×10^6	-150 to -10	0.48		142
Benzidine/I ₂ (1:0.96)	2.5×10^9				264
Benzidine/I ₂ (0.75:1)	1.6×10^5	-70 to 20	0.68	Ref. 264: $\rho = 3.3 \times 10^5$ (1:1.35)	101
(1.00:1)	6.2×10^2		0.38	Ref. 264: $\rho = 3.3 \times 10^5$ (1:1.17)	101
(1.25:1)	2.2		0.38	Ref. 264: $\rho = 2.5 \times 10^5$ to 2×10^2	101
(1.50:1)	12		0.38	(1:1.50)	101
Benzidine/1, 3, 5-trinitrobenzene	3.3×10^8				264
Benzophenothiazine/I ₂	20		0.28 to 0.40		68
2:3-Benzozquinoline/ICl	10^{13}				62
3:4-Benzozquinoline/Br ₂	10^6		0.37	Series of isomers given, com- pression at 8-12 kg/cm ² leaves ρ unaffected	162

Donor/Acceptor	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
5,6-Benzoquinoline/Br ₂	3.1x10 ⁷		1.70		162
7,8-Benzoquinoline/Br ₂	7.5x10 ⁶				162
1,2-Benzpyrene/tetracyano- quinodimethane	5x10 ¹¹		3.1		142
3,4-Benzpyrene/tetracyano- quinodimethane	4x10 ¹⁰		2.44		34
Cs/Pyrene	2.1x10 ⁴		0.42		109
Cs/1,3,6,8-tetrachloropyrene	8		0.34		109
Cs/1,3,6,8-tetrabromopyrene	16		0.35		109
Cs/1,3,6,8-tetranitropyrene	2x10 ⁶		0.94		109
Cs/1,3,6,8-tetracyanopyrene	6x10 ⁵		0.70		109
Carbazole/chloranil	< 10 ⁹				142
Carbazole/tetracyanoquinodimethane	7x10 ¹⁰	10 to 127	1.1		142
Carbon/F ₂	0.059			-	69
β -Carotene/Tri-iodide	2x10 ⁸	-48 to 27	1.1±0.1		163
p-Chloroaniline/1,3,5-trinitrobenzene	5x10 ¹³		2.72		166
Chlorpromazine/melanine	1000				84
Cobaltocene/chloranil	2.05x10 ⁴			Pressure vs ρ data given	73
Cobaltocene/2,3-dichloro-5,6-dicyanoquinone (1:1)	3x10 ³		1.8		164

Donor/Acceptor	ρ ohm.cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Cobaltocene/3,3',5,5'-tetra- chloro-p-diphenoquinone	40.1				73
Cobaltocene/tetracyanoethylene	10 ¹²	5.2			164
Cobaltocene/3,3',5,5'-tetra- bromo-p-diphenoquinone	40.1				73
Coronene/I ₂	2x10 ⁸ 10 ⁹	25 to 70	0.5	+	6,86 62
Coronene/picric acid	10 ¹²				62
Coronene/1,3,5-trinitrobenzene	10 ¹³				
Coronene/2,4,7-trinitro- fluorenone	10 ¹²				
Diaminodurene/chloranil (crystal)	X7.0x10 ⁴ Y6.9x10 ⁴	-50 to 30	0.26	+	61
(powder)	Z8.4x10 ⁴ 3x10 ⁴	-50 to 30 -50 to 30		+	61 61
1,5-Diaminophthalene/chloranil (single crystal)	X1.3x10 ⁹ Y6.3x10 ¹¹	20 to 90 20 to 90	0.6 0.74	+	61 61
(powder)	Z2.0x10 ¹¹ 7.2x10 ¹¹ 6.1x10 ¹⁰	20 to 90 20 to 90	0.74 0.65	+	61 61,62 27,26 102
1,6-Diaminobenzene/2,3-dichloro- 5,6-dicyanobenzoquinone	10 ⁶	25	0.37		277
1,5-Diaminonaphthalene/1:1 chloranil	6.1x10 ¹⁰				27,26, 102
1,6-Diaminopyrene/Br ₂	10 ⁴	-72 to 23			85

Seebeck coef. +0.3±15% V/°C

Resistance = 4.3x10⁸ Ω , thickness
0.34 cm at 12.5 Kbar

Ref. 74: ~ 100% ionic

Donor/Acceptor	ρ ohm·cm	Temp °C	E in $E/2kT$	Mobility $\frac{cm^2}{V \cdot sec}$	Sign of Major- ity Carrier	Ref.
1,6-Diaminopyrene/chloranil (single crystal)	X10 ⁹ Y10 ⁶ Z10 ⁹		0.19 0.19 0.19			61
(powder)	4x10 ³ 10 ⁴		0.15 0.30			73, 13, 62
1,6-Diaminopyrene/(1:1) chloranil	1.2x10 ⁴					27, 26, 102
1,6-Diaminopyrene/ 2,3-dichloro-5,6- dicyanobenzoquinone	10 ²				~95% ionic character	74
3,8-Diaminopyrene/chloranil	4x10 ³	25 to 70	0.15	< 10 ⁻²	+	Shows irreversible pressure effect Seebeck coef. + 0.005 V/°C 86, 6
3,8-Diaminopyrene/bromanil	1000	25 to 70	0.15	< 10 ⁻²	+	Seebeck coef. + 0.1 V/°C 86
	1000	-70 to 80	0.12			ref. 74: 35% ionic component 6, 62
3,8-Diaminopyrene/dodanil	2x10 ⁶	25 to 70	0.43 to 0.38		+	Seebeck coef. + 0.7 V/°C 86
3,10-Diaminopyrene/chloranil	3x10 ⁶ to 1x10 ⁷	25 to 70	0.39 to 0.41		+	Seebeck coef. + 0.4 V/°C 86, 62
Dibenzo [c, d] -phenothiazine/ dichloro-5,6-dicyano- p-benzoquinone (2:1)	20.7	27 to 127	0.42			no hysteresis with pressure 26 142
(3:2)	230	27 to 120	0.44			26

Donor/Acceptor	ρ ohm-cm	Temp °C	E in E/2kT	Mobility $\frac{\text{cm}^2}{\text{V}\cdot\text{sec}}$	Sign of Major- ity Carrier +	Ref.
Dibenzo [c, d] -phenothiazine/ 2, 3-dichloro-5, 6-dicyano- p-benzoquinone (2:1)	17	0 to 120	0.18		Thermoelectric power + (about 100 μ V/°C)	2
(2:1)	1.6		0.18		$\rho_0 = 5.6 \times 10^{-2}$ at 36 K bar	73
(1:1)	5000	0 to 120				2
Dibenzo [c, d] -phenothiazine/ 2, 3-dibromo-5, 6-dicyano- p-benzoquinone (1:1)	10 ⁸	0 to 120			No. of free spins/g 1.6×10^{20}	2
(3:2)	230	27 to 127	0.44		ρ affected by absorbed moisture	26
(3:2)	240	0 to 120	0.27		No. of free spins/g 4.8×10^{20}	2
	4.8		0.22		at 36 K bar; press. vs ρ for 2 to 36 K bar	73
Dimethoxybenzene/tetracyano- ethylene	10 ¹¹					62
Dimethylalanine/chloranil	1.0x10 ⁷ 5x10 ⁷ ac	20 to -45	0.47			93
	8.1x10 ⁸ dc		0.47			152
	1.0x10 ⁹	15	0.47			62
Dimethylalanine/bromanil	1.7x10 ⁹ 9x10 ⁷ ac	20 to -45	0.45			93
	1.5x10 ⁹ dc		0.45			152
Dimethylalanine/iodanil	1.9x10 ⁸ 3x10 ⁷ ac	20 to -45	0.43			93
	1.7x10 ⁸ dc		0.43			152
N, N-Dimethylalanine/ 1, 3, 5-trinitrobenzene	1x10 ⁶		2.08		ref. 62: $\rho = 10^8$ single crystal	63, 166 142

Donor/Acceptor	ρ ohm-cm	Temp °C	E in E/2kT	Mobility $\frac{\text{cm}^2}{\text{V}\cdot\text{sec}}$	Sign of Major- ity Carrier	Ref.
Durenediamine/chloranil	1.80×10^{15}		0.475			ref. 73: $\rho = 8.4 \times 10^4$, $\rho_0 = 9.39 \times 10^1$ 59, 73
N-Ethylcarbazole/Tetra- cyanoquinodimethane (1:1)	$-.8 \times 10^{13}$	10 to 127	1.1			142
Ferrocene/2,3-dichloro-5,6- dicyanoquinone (1:1)	3×10^{10}		1.4			164
Ferrocene/tetracyanoethylene	3×10^{12} 10^9					164 142
Graphite/Br ₂	10^{-4}	25 to -196			+	87
(fully brominated)	2.6 to 4.5×10^{-3} 6.3×10^{-6}					69 142
Hexamethylbenzene/chloranil	10^{11}					62
Hexamethylbenzene/tetra- cyanoethylene	4.1×10^{13} 10^{11}	20 to 85	-.16			66 62
1-Hydroxy-anthraquinone/ 1.8-naphthalic anhydride	3.05×10^5					25
Li / anthracene (1.16:1)	10^{11} 2.2×10^{11}	25 to 50	1.34 2.72		ρ vs load given	165 165
Lumiflavin/hydroquinone	2×10^{10}					212
Methylamine/chloranil	10^{14}	10 to 70	58 to 1.02			142
N-Methylphenothiazine/I ₂	1.4	20	0.28			68
Naphtholene/tetracyano- ethylene	3.2×10^{15}	20 to 85	2.48			6,66, 113
β -Naphthol/2,4,7- trinitrofluorenone	10^{13} to 10^{18}		1.8		ρ vs varying frequencies	58

Donor/Acceptor	ρ ohm-cm	Temp °C	E in E/2kT	Mobility $\frac{\text{cm}^2}{\text{V}\cdot\text{sec}}$	Sign of Major- ity Carrier	Ref.
α -Naphthylamine/1,3,5-trinitrobenzene	3×10^7	20 to 85	2.48			6,66, 113
1,5-Naphthylenediamine/I ₂ (0.75:1)	6.1×10^7		1.32			
(1.00:1)	1.6×10^6		0.84			101
(1.25:1)	1.0×10^6		0.80			
(1.50:1)	3.1×10^5		0.64			
Pentanethylbenzene/ tetracyanoethylene	4.4×10^{13}	20 to 85	1.12			66
Perylene/Benzoquinone	3×10^6		0.9			
Perylene/Br ₂	7.8	-20 to -170	0.13			167, 168
Perylene/chloranil	2.8×10^{11}				ref. 78: $\rho_0 =$ 1 ohm cm	108, 106, 78, 93
(single crystal)	3×10^{14}		0.73			27, 26, 102
Perylene/fluoranil mean	6×10^{13}		0.73			142
Single crystal { c	8.5×10^{13}					142
{ ⊥ c	2×10^{14}					142
{ c	6.6×10^{13}		1.46			142
{ ⊥ c	2x	1.46				142
compacted 1:1	2.4×10^{12}					142
Perylene/I ₂	10		0.06			27, 26, 102
(1:1)	8	-70 to 20	-0.038		ref. 232: spin	113
(1:1)		-180 to 25		< 0.01	concentration (ESR)	31
(1:3)	6.3			Ref. 100: $X_M = -342 \times 10^{-6}$	@ 300°K = 4.6×10^{19}	
(2:3)	3.0-8.0			Ref. 100: $X_M = -217 \times 10^{-6}$	for 2 Perylene · 3 I ₂	26, 27, 102
(1:1)	2 to 3	25 to 70	0.011 to 0.019		complex stable in closed container	26, 27, 102
					see also: 6, 66, 62, 59, 232	86

Donor/Acceptor	ρ ohm·cm	Temp °C	E in E/2kT	Mobility $\frac{\text{cm}^2}{\text{V}\cdot\text{sec}}$	Sign of Major- ity Carrier	Ref.
Perylene/metal halides	10 ⁵		0.5		+ or -	88
Perlene/Sb Cl ₅	32	-73 to +20 -73 to -155	0.196 0.134			60
Perlyene/tetracyanoethylene (single crystal)	2.4x10 ¹²	20 to 85	1.44			ref. 6: molecular structure apparently changed with pressure 6,66, 113
Perlene/I Cl	10 ⁵	7 to 40	0.34		+	Seebeck coeff. +0.015 V/°C 114, 142
Perylene/Pt Cl ₄	10 ⁷ to 10 ⁹	7 to 40	1.0		+	Seebeck coeff. +0.04 V/°C 114, 142
Perylene/Sb Cl ₅	625	7 to 40	0.34			114
Perylene/Sb Cl ₃	3.6x10 ⁹	7 to 40	1.06			114
Perylene/tetracyanoethylene	10 ¹⁴	7 to 40				114
Perylene/I ₂	125	7 to 40	0.2		+	Seebeck coeff. +0.035 V/°C -0.01 V/°C Decomposes 204° 114, 142 277
Perylene/ 2,3-dichloro-5,6- dicyanobenzoquinone	3x10 ⁶	25	0.45			
Perylene/Fe Cl ₂	7.7x10 ⁵	7 to 40	0.5			114
Perylene/Fe Cl ₃	8.3x10 ⁶	7 to 40	0.66			114
Perylene/Os Cl ₃	5.9x10 ¹⁰	7 to 40	1.2			114
Phenanthrene/tetracyano- ethylene	2.2x10 ¹²	20 to 85	1.52			66, 113
Penanthrene/1,3,5-trinitro- benzene	7x10 ¹⁸		2.48			113, 142

Donor/Acceptor	ρ ohm·cm	Temp °C	E in E/2kT	Mobility $\frac{\text{cm}^2}{\text{V}\cdot\text{sec}}$	Sign of Major- ity Carrier	Ref.
Phenazine/o-hydroquinone	7×10^{12}	0.5				142
Phenazine/dehydrophenazine	3.7×10^{10}	1.3 to 1.5				142
Phenazinium chloride/ pyrene	6×10^{10}	1.2				142
Phenazinium chloride/ p-hydroquinone	3×10^{11}	1.1 to 1.5				142
Phenazinium methosulfate/ pyrene	1.5×10^{13}	2.8				142
Phenazinium methosulfate/ p-hydroquinone	2.9×10^{12}	3.7				142
Phenothiazine/I ₂	20	0.34				68
Phenothiazine/I ₂ (recrystallized)	20	0.28 to 0.40				68
m-Phenylenediamine/ chloranil (5:3)	5×10^8	-90 to 50	1.17			142
p-Phenylenediamine/ chloranil (1:1)	2×10^7	15 to 100	0.86		+ see also ref. 1, 27, 167, 170	142
	5×10^6	0.570			ref. 170: Seebeck coeff. 1.1×10^{-3} V deg ⁻¹ °C	6
					Thermal conductivity 2.0×10^{-3} W cm ⁻¹ deg ⁻¹ °C	62
p-Phenylenediamine/benzo- quinone	10^6	0.74				167
Phenylenediamine/chloranil	6×10^6 to 1×10^8	25 to 70	0.57 to 0.65			86

Donor/Acceptor	ρ ohm·cm	Temp °C	E in E/2kT	Mobility $\frac{\text{cm}^2}{\text{V}\cdot\text{sec}}$	Sign of Major- ity Carrier	Ref.
p-Phenylenediamine/chloranil	5×10^5	-10 to 20	0.5			1, 169
	6×10^6	25	1.67			86
	5×10^7	-23 to 57	1.14			170
	4.3×10^6				Thermal cond.: + 2.0×10^{-3} w./cm. °C	Seebeck coef. +0.83 to 1.22 mV deg ⁻¹ °C
p-Phenylenediamine/fluoranil	$\sim 10^9$					26, 27, 102
p-Phenylenediamine/iodanil	10^{11}					6
p-Phenylenediamine/I ₂	10^5					62
(0.45:1)	5.3×10^3	25 to 85	1.60		ortho - $\rho = 10^9$, meta - $\rho = 10^7$	295
(0.67:1)	3.5×10^7	25 to 85	1.22			115
(0.82:1)	1.7×10^5	25 to 85	0.82			115
(1.03:1)	2.7×10^5	25 to 85	0.88			115
(1.36:1)	1.04×10^6	25 to 85	0.96			115
(1.62:1)	5.4×10^6	25 to 85	1.18			115
(3:1)	2×10^{10}	27				6, 62
p-Phenylenediamine deriva- tives/I ₂	3	-20 to 90	0.086			107
p-Phenyldiamine/1, 3, 5- trinitrobenzene	0.8×10^{16}		2.04			113, 142
Poly(4-vinyl) pyridine/I ₂						
(2:1)	10^4		1.3			116
(3.3:1)	10^7					116
Phthalocyanine/chloranil	100	25 to -100	0.4	10^{-4}	+	Seebeck coef. +0.130 mV deg ⁻¹ °C 117
K / anthracene	10^{11}	25 to 50	2.20			$\rho_0 = 2.2 \times 10^4$ 165

Donor/Acceptor	ρ ohm·cm	Temp °C	E in E/2k	Sign of Major- ity carrier	Ref.
K/ graphite	1.72 to 0.68x10 ⁻³		-183 to 15	+	69
					29,70 29,70 29,70
K 1.42: Isoviolanthrene	1	2600	0.28		62, 93, 108, 106, 78
4:05:	1	100	0.166	-	93
4:35:	1	27	0.060	-	167
Pyranthrene/Br ₂	220	-20 to -170	0.20		142 142
					31,62 35,66
Pyranthrene/I ₂	17	0.09			113,66 171
Pyrene/Benzoquinone	10 ¹³	1.8		-	277
Pyrene/chloranil	10 ¹⁶	0.73			113, 142
Pyrene/Tetracyanoquino- dinemethane	10 ¹⁶	0.73			212
Pyrene/I ₂	75 77	-18 to -70 15	0.136 0.14-0.28		
Pyrene/Tetracyanoethylene	4.5x10 ¹⁵	20 to 85	1.65	+	
Pyrene/2, 3-dichloro-5, 6- dicyanobenzoquinone	10 ¹³	25	0.9		
Pyrene/1, 3, 5-trinitrobenzene	1x10 ²⁰	2.20			
Riboflavin/hydroquinone	1x10 ⁶				

Ref. 252: $\Delta H_f = 6.6$ kcal/CgK,
11.92 kcal/C₂₄K
 $\rho_o = 1.0 \times 10^{-3}$

Ref. 78: $\rho_o = 3 \times 10^{-2}$ ohm·cm

Mobility: 0.01 cm²/V·sec

Mobility: $\mu_- = 10^{-2}$ cm²/V·sec
 $\mu_+ = 30$

Decomposes 233-40C

1x10⁸ ohm·cm after 30 hrs.
electrolysis

Donor/Acceptor	ρ ohm·cm 1.5×10^8	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Riboflavin/resorcinol				ρ unchanged after 30 hrs. electrolysis	212
Na 1.07/Acridine	1.2×10^{16}	293	3.98		162
Na/Anthracene	$10^8 - 10^{10}$	25 to 50	0.63	Ratio 1.08 to 2.12:1 given with ρ values	165
Na 1.60/Ahthracene (Et_2O) 0.30	6.2×10^{10}		0.26		166, 162
Na/3,4-benzoquinoline (1.5:1)	10^{10}		0.35		162
Na/5,6-benzoquinoline (1.6:1)	1.4×10^{11}		2.36		162
Na/7,8-benzoquinoline (1.10:1)	4×10^{17}		4.30		162
Na/Bromanil	$< 10^{10}$				74
Na/Isoviolanthrene (0.31:1) (2.37:1)	3.1×10^5 61		0.42 0.092	- -	29,70 29,70
Tetramethylbenzidine/chloranil	2.3×10^7				26,27,
Tetramethylbenzene/ Br_2 (1:48)	1×10^6			(1:51) $\rho = 3.3 \times 10^5$	102 264
Tetramethylbenzidine/fluoranil	2.8×10^{12}				26,27, 102
Tetramethylbenzidine/ I_2 (1:135)	1.6×10^9				264
Tetramethyl-p-phenylene- diamine/chloranil	2.4×10^4 1.3×10^4 ac 2.0×10^4 dc	0 to 25	0.53 0.53		93,6, 62 89
Tetramethyl-p-phenylene- diamine/bromanil	1.6×10^5 4.2×10^4 ac 1.3×10^5 dc	10 to 25	0.56 0.56		6,93 89

Donor/Acceptor	ρ ohm-cm	Temp °C	E in E/2kT	Major- ity Carrier	Ref.
Tetramethyl-p-phenylene- diamine/iodanil	1.8x10 ⁶ 1.1x10 ⁵ ac 1.5x10 ⁶ dc	15 -10 to -30	0.59 0.59		93 89
Tetrathiotetracene/chloranil	2 to 4	0 to 120	0.20	+	67
Thermoelectric power = 20 to 30 μ V/°C					
Tetrathiotetracene/o-chloranil (3:1)	5.6	20 to 120	0.24		26
(3:1)	0.30	0.040			73
$\rho_0 = 4.0 \times 10^{-1}$, ρ vs P given for 2 to 36 Kbar					
Tetrathiotetracene/o-bromanil	6 to 8	0 to 120	0.20	+	67
(3:1)	1.8	27 to 120	0.24		26
	0.42	27	0.02		73, 26
$\rho_0 = 2.4 \times 10^{-1}$; ρ vs P from 2 to 36 Kbar					
Tetrathiotetracene/ tetracyanoethylene	15	0 to 120	0.20	+	67
Thermoelectric power = +20 to +30 μ V/°C					
o-Toluidine/I ₂	3500	0.54			101
(0.75:1)	290	0.48			101
(1.00:1)	29	0.36			101
(1.25:1)	91	0.36			101
(1.50:1)					
Triethylamine/chloranil	10 ¹⁴	10 to 70	0.88 to 1.7		142
Violanthrene/Br ₂	66	-20 to -170	0.20		93, 78 108, 1
Violanthrene/I ₂	45	-20 to -170	0.15		93
(1:1)	45	10 to 60	0.14		93
(1:3.17)	127	-180 to 15	0.25	+	100
(1:1.90)	18.0	-180 to 15	0.14	+	100
(1:1.31)	24.0	-180 to 15	0.18	+	100
Mobility: 1.7x10 ⁻³ cm ² /V.sec " 2.7x10 ⁻³ " " 5.4x10 ⁻³ "					

Donor/Acceptor	ρ ohm-cm	Temp °C	E in E/2kT	Sign of Majority Carrier		Ref.
Violanthrene/I ₂ (continued)						
(1:0.118)	2.2x10 ²	-180 to 15	0.18	+	Mobility 4.7x10 ⁻³ cm ² /V-sec	100
(1:1x10 ⁻²)	3.1x10 ⁵	15 to 90	0.45	+	" 8.4x10 ⁻³ "	100
(1:3.6x10 ⁻³)	2.8x10 ⁷	15 to 90	0.45	+	" 2.6x10 ⁻⁴ "	100
(1:3x10 ⁻⁴)	6x10 ⁸			+	" 5.4x10 ⁻⁴ "	100
(1:5x10 ⁻⁴)	1.4x10 ⁹	15 to 65	0.44	+	" 3x10 ⁻⁵ "	100
(nil)	2.0x10 ¹⁴	60 to 200	0.94	+		100
Violanthrene/tetracyanoethylene	5.2x10 ⁸	20 to 85	0.35			66
Violanthrene/1, 3, 5-trinitro- benzene	5x10 ¹³		1.14			113 142
Isoviolanthrene/AlCl ₃ (1:3.7)	2.6x10 ¹²		1.30			29, 70
(1:3.2)	36		0.22	-		29, 70
Isoviolanthrene/TiCl ₄ (1:1.87)	3.0x10 ¹⁰		1.28		$\rho_o = 0.69$, density 1.56	29
(1:1.29)	354		0.26	-		29, 70
Isoviolanthrene/ICl	4.5x10 ¹¹		1.24		Attacked by water and oxygen	29, 70
(1:1.90)	2.2x10 ⁸		0.94			29, 70
(1:3.73)	1.1x10 ⁹		0.98			29, 70
Isoviolanthrene/I ₂	580		0.22		Seebeck coef. -0.3 V/°C	29, 70
(1:1.52)						
Isoviolanthrene/Na	61		0.96		$\rho_o = 10$ Thermoelectric power -10 μ V/°C	29
(1:0.31)	3.1x10 ⁵		0.42		$\rho_o = 2.6$ attacked by water and oxygen	29
Isoviolanthrene/K	27		0.060		$\rho_o = 8.9$ Thermoelectric power -20 μ V/°C	29
(1:4.35)						
(1:4.05)	100.0		0.166		$\rho_o = 3.7$ Thermoelectric power -10 μ V/°C	29
(1:1.42)	2600		0.028		$\rho_o = 5.2$ Attacked by water and oxygen	29

TABLE 4

FREE RADICALS AND RADICAL SALTS

Substance*	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier		Ref.
Banfield and Kenyon's Radical	10 ¹⁵	40 to 25	2.31		$\rho_0 \approx 10^5$	146, 77
Ba: (TCNQ) ₂	5x10 ⁷	0 to 25	0.90	+	Seebeck coef. +1 to 1.5mV/°C	30, 33
2-Bromopyridine (TCNQ) ₂	21.5 to 1115					257
(3-bromoquinolinium) ₂ (TCNQ) ₂	0.5					257
(C ₂ H ₅) ₃ NH (TCNQ) ₂	1000		0.1-0.3	-		119
Cs (TCNQ)	2x10 ³	0 to 25	0.36	+		30, 33
Cs (TCNQ) _{1.5}	10 ⁵			-		30, 33
Cs (TCNQ) ₃ (single crystal)	1000	0 to 25	0.60		Seebeck coef. -1.1mV/°C Mobility < 0.1 cm ² /V·sec	30, 33
Cs ₂ (TCNQ) ₃	2.5x10 ⁴ 2.5x10 ⁴					
Cu (TCNQ)	1000		0.1-0.3		Seebeck coef. -0.5mV/°C	119
4-Cyano-N-methylquinolinium (TCNQ) ₂ (single crystal)	100 1,50 33	0 to 25 0 to 25	0.32 0.16	-	Ref. 257: m.p. < 300°C	30, 33 30, 33 30, 33
4-Cyano-N-methylquinolinium (TCNQ)	1.4x10 ⁵	0 to 25			Ref. 257: m.p. 196-8°C	30, 33
4-Cyano-N-methylquinolinium (TCNQ) ₂	50	0 to 25				30, 33
3,7-diamino-2,8-dimethyl- 5-phenylphenazinium (TCNQ) ₂					m.p. > 230°C decomposes	257

* (TCNQ) = 7,7,8,8-Tetracyanoquinodimethane
(TCNQD) = 7,7,8,8-Tetracyanoquinodimethane - Li salt

Substance*	ρ ohm-cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier		Ref.
3, 7-diamino-2, 8-dimethyl-5-phenylphenazinium (TCNQD)	6.4×10^6				m. p. = 185-210°C decomposes	257
Di minodurene (TCNQ) ₂	2	0 to 25	0.16			30, 33
1, 6-Diaminopyrene (TCNQ)	0.5	-72 to 23	0.28	+	Seebeck coef. +0.052mV/°C	13
1, 6-Diaminopyrene Br ₂	10 ⁴				Seebeck coef. +0.052mV/°C	13
5, 8-Dihydroxyquinolinium (TCNQ)	10 14		0.14	+		30, 33 72
α, α' -diphenyl- β -picrylhydrazyl (DPPH)	1.3×10^{10} dc 1.5×10^8 ac	20 to 100	0.15 0.26		$\rho_o = 10^{-7}$ $\rho_o = 10^{-8}$	82, 147
DPPH	0.17×10^8 ac		0.263			82, 143
DPPH c-axis single x-axis crystal Thin film	4.6×10^{10} 2.6×10^{10} 1010		1.22 1.7 ev	-	Mobility < 1 cm ² /V-sec Surface-type cell	149, 150 151 304
Galvinoxyl (Copper's radical)	1013		1.45			152
Fe (TCNQ) ₂ · 3H ₂ O	5×10^4	0 to 25	0.48	+		30, 33
Li (TCNQ)	2×10^4	0 to 25	0.64	-	Seebeck coef. -0.6 to -1.4 mV/°C	30, 33, 72
Mn(TCNQ) ₂ · 3H ₂ O	10 ⁵	0 to 25	0.32			30, 33
N-Methyl-2, 3-benzoquinolinium (TCNQ) ₂ (single crystal)	36		0.22		Ref. 257: m. p. = 170°C	120, 33
N-Methyl-3, 4-benzoquinolinium (TCNQ) ₂ (single crystal)	230		0.28			120, 33

* (TCNQ) = 7, 7, 8, 8-Tetracyanoquinodimethane
(TCNQD) = 7, 7, 8, 8-Tetracyanoquinodimethane - Li salt

Substance*	ρ ohm-cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
N-Methyl-7,8-benzoquinolinium (TCNQ) ₂ (single crystal)	125		0.30		120, 33
N-Methylquinolinium (TCNQ) ₂	2 to 10 331.3	0 to 25	0.14		30, 33 257
N-Methylquinolinium(TCNQ) ₂ (single crystal)	0.01	0 to 25	0.14	-	30, 33
N-Methylquinolinium (TCNQ)	107				30, 33
N-Methylquinoxalinium(TCNQ)	62				257
N-Methyl-2-styrylpyridinium (TCNQ) ₂	6.6				257
N-methyl-2-styrylpyridinium (TCNQD)	3.7×10^7				257
Methyl derivative of (TCNQ)/ methyl phenazinium	3×10^6				257
Methyl derivative of (TCNQ)/ methyiltriphenylarsonium	57				257
Mono(2,2'-bipyridine) copper (TCNQ) bis (TCNQD)	19				257
Mono(1,10-phenanthroline)copper 15 (II) (TCNQ) ₄					257
Mono(1,10-phenanthroline) copper(II) bis (TCNQD)	34				257
Morpholinium (TCNQ) (single crystal)	10 ⁹	0 to 25	0.64		30, 33

m. p. = 180°C

* (TCNQ) = 7,7,8,8-Tetracyanoquinodimethane
(TCNQD) = 7,7,8,8-Tetracyanoquinodimethane - Li Salt

Substance*	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Phenazinium chloride-pyrene	6×10^{10}	20 to 50	1.2		153
Phenazinium complex salts	10^{11} to 10^{16}		0.5 to 3.7		153
Poly(N-vinylcarbazole)- (TCNQ)	10^{14} to 10^{16}		1.1 to 1.5		302
Poly(4-vinylpyridine)-TCNQ	1.58×10^{17} 18°				303
K (TCNQ) ₂	> 100		> 0.2	-	119
K(TCNQ)	5×10^3 10^4	0 to 25 0 to 25	0.72 0.70	+ +	30, 33 30, 33
Pyridium pyridine (TCNQ) ₂	123.1				257
Pyridine (TCNQ) ₂	85				257
Quinoline · hydroquinoline	2.7×10^{14}				257
Quinolinium (TCNQ) ₂	< 100		< 0.1		119
Quinolinium (TCNQ) ₂ (single crystal)	0.01		< 0.02		30, 33, 54, 36, 72
Quinolinium (TCNQ) ₂	0.01				301
Quinolinium (TCNQ) ₂ (single crystal)	0.25 31.5	0	0.06	-	30, 33 257
Quinolinium/acetyldiethylamine (TCNQ) ₂	0.01 3.4	0 to 25	0.06		30, 33
					257

* (TCNQ) = 7, 7, 8, 8-Tetracyanoquinodimethane

Substance*	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Quinolinium/2-bromopyridine (TCNQ) ₂	49.8				257
Quinolinium/2-chloropyridine (TCNQ) ₂	9.0				257
Quinolinium/pyridine(TCNQ) ₂	12.7				257
Ag (TCNQ)	2x10 ⁴	0 to 25	0.74	-	30, 33
Na (TCNQ)	10 ⁵	0 to 25	0.66		30, 33
Tributylamine (TCNQ) ₂	8.2 to 10				257
Triethylammonium(TCNQ) ₂ (2:1)	109				30, 33
Triethylammonium(TCNQ) ₂	20				257
Triethylammonium (TCNQ) ₂ (single crystal)	0.25 25 1000	0 to 25	0.28	-	30, 33 54
Trimethylammonium(TCNQ) ₂ (2:1)	5x10 ⁶	0 to 25	0.86		30, 33
Triphenylmethylarsonium (TCNQ) ₂ (single crystal)	50 500 10 ⁵	0 to 25	0.60		30, 33 54
Triphenylmethylphosphonium (TCNQ) (single crystal)	5x10 ¹⁰				30, 33
Triphenylmethylphosphonium (TCNQ) ₂ (single crystal)	50 500 10 ⁵	0 to 25	0.60	+	30, 33

* (TCNQ)₂ = 7, 7, 8, 8-Tetracyanoquinodimethane

Substance*	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
2,4,6-Triphenylperylum (TCNQ) ₂	10		0.08		30,33
Tris (2,2'-bipyridine) nickel (II)-bis-(TCNQD)	10 ⁵				257
Tris (2,2'-bipyridine) nickel (II)-bis-(TCNQD) ₂ -bis-(TCNQ)	2x10 ³				257
Tris (1,10-phenanthroline) cobalt (II) bis-(TCNQD)	10 ⁷				257
Tris (1,10-phenanthroline) cobalt (II) bis-(TCNQD) bis-(TCNQ)	10 ⁴				257
Tris (1,10-phenanthroline) copper (II) bis-(TCNQD)	10 ⁵				257
Tris (1,10-phenanthroline) copper (II) bis-(TCNQD)-bis-(TCNQ)	10 ⁴				257
Tris (1,10-phenanthroline) manganese(II) bis-(TCNQD)	10 ³				257
Tris (1,10-phenanthroline) manganese (II) bis-(TCNQD)- bis-(TCNQ)	140				257
Tris (1,10-phenanthroline) nickel (II) bis-(TCNQD)	10 ⁴				257
Tris (1,10-phenanthroline) nickel (II) bis-(TCNQD) - bis-(TCNQ)	200				257
Violanthene - B compound	7x10 ⁶ 1.1x10 ¹¹		0.67 0.79		93

* (TCNQ) = 7,7,8,8-Tetracyanoquinodimethane
(TCNQD) = 7,7,8,8-Tetracyanoquinodimethanide - Li salt

TABLE 5

POLYACENEQUINONE RADICAL POLYMERS

Hydrocarbon/Acidic Derivatives	ρ ohm-cm	Temp ° C	E in E/2kT	Mobility $\frac{\text{cm}^2}{\text{V}\cdot\text{sec}}$	Sign of Major- ity Carrier	Ref.
7-Acenaphthol/1,8-naphthalic anhydride	1.37×10^8		0.60			172
7-Acenaphthol/pyromellitic dianhydride	4.9×10^7		0.71			172
7-Acenaphthol/phthalic anhydride	4.2×10^7		0.58			172
Anthracene/phthalic anhydride (2:1)	9.5×10^7	25	0.698			75
Anthracene/pyromellitic dianhydride	4.53×10^6				$\rho_o = 70.8$ ρ vs load at 25°C and 105°C	25
Anthracene/terephthaloyl chloride (1:1)	1.3×10^8	25				75
Anthraquinone/pyromellitic anhydride (3:1)	2.0×10^4	25	0.382		$\rho_o = 8.90$	75
1,4-Bisanthraquinonylamino-anthraquinone/1,8-naphthalic anhydride	2.7×10^6		0.472			172
1,4-Bisanthraquinonylamino-anthraquinone/pyromellitic dianhydride	1.5×10^7		0.515			172
1-Bromo-2-naphthol/1,8-naphthalic anhydride	6.8×10^6		0.53			172
1-Bromo-2-naphthol/pyromellitic dianhydride	1.13×10^7		0.68			172
1-Bromo-2-naphthol/phthalic anhydride	4.6×10^6		0.62		+	172
6-Bromo-2-naphthol/1,8-naphthalic anhydride	9.6×10^5		0.58			172
	2.9×10^6		0.571			172

Hydrocarbon/Acidic Derivatives	ρ ohm·cm	Temp ° C	E in E/2kT	Mobility $\frac{\text{cm}^2}{\text{V}\cdot\text{sec}}$	Sign of Major- ity Carrier	Ref.
6-Bromo-2-naphthol/pyromellitic anhydride	5.9×10^6		0.66			172
6-Bromo-2-naphthol/phthalic anhydride	7.2×10^6		0.58			172
9-Bromophenanthrene/1,8- naphthalic anhydride	5.6×10^6		0.34			172
2-Bromo-4-phenylphenol/1,8- naphthalic anhydride	1.0×10^{11}		1.20			172
2-Bromo-4-phenylphenol/ phthalic anhydride	2.3×10^8		0.62			172
Carbazole/1,8-naphthalic anhydride	2.1×10^8		0.59			172
Carbazole/phthalic anhydride β	1.9×10^8		0.54			172
Dibenzanthrone (violanthrone)/ pyromellitic dianhydride	1.9×10^8		0.43			172
1,2-Dihydroxyanthraquinone/ 1,8-naphthalic anhydride	7.9×10^7		0.690			172
1,2-Dihydroxyanthraquinone/ 1,8-naphthalic anhydride	2.1×10^7		0.68			172
1,4-Dihydroxyanthraquinone/ 1,8-naphthalic anhydride	1.8×10^7		0.50			172
1,4-Dihydroxyanthroquinone/ pyromellitic dianhydride	7.0×10^9 5.5×10^8		0.570			172
1,5-Dihydroxyanthroquinone/ 1,8-naphthalic anhydride	3.6×10^5 5.2×10^6		0.63 0.703		+	172 172
1,5-Dihydroxyanthroquinone/ pyromellitic dianhydride	5.8×10^8		0.845			172

Hydrocarbon/Acidic Derivatives	ρ ohm·cm	Temp °C	E in E/2kT	Mobility $\frac{\text{cm}^2}{\text{V}\cdot\text{sec}}$	Sign of Major- ity Carrier	Ref.
1, 8-Dihydroxyanthraquinone/ 1, 8-naphthalic anhydride	2.8x10 ⁵ 2.2x10 ⁷		0.52 0.766		+	172
1, 8-Dihydroxyanthraquinone/ pyromellitic dianhydride	9.2x10 ⁷ 2.3x10 ⁸		0.67 0.563			172
1, 8-Dihydroxyanthraquinone/ tetraphenyl-1, 2-dihydro- phthalic anhydride	2.9x10 ⁵		0.52			172
1, 4-Dihydroxynaphthalene/1, 8- naphthalic anhydride	10 ¹²		1.11			172
1, 4-Dihydroxynaphthalene/ pyromellitic dianhydride	5.6x10 ¹¹ 1.4x10 ⁹		1.00			172
1, 4-Dihydroxynaphthalene/ phthalic anhydride	1.01x10 ⁸		0.56			172
2, 3-Dihydroxynaphthalene/1, 8- naphthalic anhydride	9.4x10 ⁷		0.58			172
2, 7-Dihydroxynaphthalene/ pyromellitic dianhydride	3.3x10 ¹⁰		1.83			172
p, p'-Diphenol/phthalic anhydride	1.0x10 ¹²					172
1, 4-Diphenylpiperazine/ phthalic anhydride	2.0x10 ¹²					172
1-Hydroxyanthraquinone/1, 8- naphthalic anhydride	1.34x10 ⁶ 5.0x10 ⁵		0.62 0.503		+	172
1-Hydroxyanthraquinone/ phthalic anhydride	6.0x10 ⁶		0.58			172
1-Hydroxyanthraquinone/ pyromellitic dianhydride	7.0x10 ⁵					172
Hydroquinone/phthalic anhydride	1.4x10 ⁶		0.58			263

Hydrocarbon/Acidic Derivatives	ρ ohm-cm	Temp ° C	E in E/2kT	Mobility $\frac{\text{cm}^2}{\text{V}\cdot\text{sec}}$	Sign of Major- ity Carrier	Ref.
p-Naphthalobenzoin/1,8-naphthalic anhydride	1.0×10^{11}		0.68			172
p-Naphthalbenzein/phthalic anhydride	1.3×10^8		0.13			172
α -Naphthalphthalein/phthalic anhydride (2:1)	6.5×10^6	25	0.544		$\rho_o = 05.0$	75
Phenanthrene/acetic anhydride (2:1)	4.1×10^8	25				75
Phenanthrene/benzoic acid (1:1)	2.4×10^5	25	0.444		$\rho_o = 30.1$	75
Phenol/phthalic anhydride (4:3)	1.1×10^8	25	0.638		$\rho_o = 276$	75
Phenolphthalein/1,8-naphthalic anhydride	6.4×10^6		0.77		+	172
Phenolphthalein/phthalic anhydride (2:1)	6.0×10^8		0.60			172
Phenolphthalein/pyromellitic dianhydride	8.8×10^7	25				75
	5.3×10^9		0.65			172
Terephthaloyl chloride/naphthalene	6.0×10^{11}		0.956		$\rho_o = 251$	75
1,4,9,10-Tetrahydroxyanthracene/1,8-naphthalic anhydride	8.7×10^5		0.516			172
	2.4×10^6		0.63			172
1,4,9,10-Tetrahydroxyanthracene/phthalic anhydride	1.39×10^7					172

Hydrocarbon/Acidic Derivatives	ρ ohm·cm	Temp °C	E in E/2kT	Mobility $\frac{\text{cm}^2}{\text{V}\cdot\text{sec}}$	Sign of Majority Carrier	Ref.
Polyacenequinone Radical copolymer pyrolyzed/ pyromellitic dianhydride	0.03	25 to 100	-0.001		+	111
Polyacenequinone radical polymers prepared at 256°C	4.4×10^4 to 1.0×10^6		0.516 to 0.680			118
Pyrene/pyromellitic dianhydride	2.58×10^4	25				25
Terphenyl/pyromellitic dianhydride	7.7×10^6	25			ρ vs load plot at different T	25
Triphenylchloromethane/ pyromellitic dianhydride	5.5×10^{13}	25			ρ vs load plot at different T	25

Polymer Reactants	ρ ohm·cm	Temp °C	E in E/2kT	Mobility $\frac{\text{cm}^2}{\text{V}\cdot\text{sec}}$	Mole Ratio	Catalyst	Ref.
Alizarin/pyromellitic anhydride	1.5×10^6	25	0.46	1.29×10^{-3}	1:1:1	ZnCl ₂ $\rho_0 = 1.9 \times 10^2$	55
Alizarin/pyrene/ pyromellitic anhydride	1.3×10^4	25			2:2:2:3	ZnCl ₂	55
Anaranth/pyromellitic anhydride	5.8×10^8	25			1:1:1	ZnCl ₂	55
Amaranth/pyrene/ pyromellitic anhydride	1.0×10^8	25			2:2:2:3	ZnCl ₂	55
Aniline black/pyromellitic anhydride	5.2×10^7	25	1.01	4.37×10^{-6}	1:1:1	ZnCl ₂ $\rho_0 = 1.4 \times 10^{-1}$	55
Aniline black/pyromellitic anhydride	1.4×10^6	25	0.11	1.52×10^{-6}	2:2:2:3	ZnCl ₂ $\rho_0 = 1.5 \times 10^{-1}$	55
Anthracene/pyromellitic anhydride	2.4×10^6	25			1:1:1	ZnCl ₂	55
Benzoazurine G/ pyromellitic anhydride	3.32×10^6		0.534				65
Benzoazurine G/ pyromellitic anhydride	3.1×10^7	25			1:1:1	ZnCl ₂	55
Benzoazurine G/pyrene/ pyromellitic anhydride	2.4×10^{10}	25			2:2:2:3	ZnCl ₂	55
Chrysene/pyromellitic anhydride	1.0×10^6	29	0.387			ZnCl ₂	65
Congo Red/pyromellitic anhydride	3.1×10^7	25			1:1:1	ZnCl ₂	55
Congo Red/pyromellitic anhydride	7.4×10^9	25			2:2:2:3	ZnCl ₂	55
Dibenzpyrene/pyromellitic anhydride	7.4×10^9	25			2:2:2:3	ZnCl ₂	65

Polymer Reactants	ρ ohm·cm	Temp °C	E in E/2kT	Mobility $\frac{\text{cm}^2}{\text{V} \cdot \text{sec}}$	Mole Ratio	Catalyst	ρ_o	Ref
2, 5-Dichloro-3, 6-dihydroxy- p-benzoquinone/pyromellitic anhydride	7.2×10^8	25	1.20	4.92	1:1:1	ZnCl ₂	$\rho_o = 5.1 \times 10^{-2}$	55
2, 5-dihydroxy-p-benzoquinone/ pyromellitic anhydride	5.4×10^8	25	0.95	2.54×10^{-5}	1:1:1	ZnCl ₂	$\rho_o = 4.8$	55
Eosine Y/pyromellitic anhydride	1.3×10^9	25			1:1:1	ZnCl ₂		55
Eosine Y/pyrene/promellitic anhydride	1.0×10^6	25	0.11	2.13×10^{-6}	2:2:2:3	ZnCl ₂	$\rho_o = 8.9 \times 10^1$	55
Ferrocene/salicylic acid	2.5×10^8	50	0.33		1:1:8	t-butyl peroxide		237
Fluorescein/pyromellitic anhydride	7.7×10^{10}	25			1:1:1	ZnCl ₂		55
Fluorescein/pyrene/ pyromellitic anhydride	7.1×10^7	25	0.38	5.85×10^{-6}	2:2:2:3	ZnCl ₂	$\rho_o = 2.7 \times 10^1$	55
Indigo/pyromellitic anhydride	3.9×10^6	25			1:1:1	ZnCl ₂		55
Indigo/pyromellitic anhydride	1.5×10^5	25			2:2:2:3	ZnCl ₂		55
Meldola blue/promellitic anhydride	1.7×10^8	25	0.82	1.31×10^{-2}	1:1:1	ZnCl ₂	$\rho_o = 1.9 \times 10^1$	55
Meldola blue/pyrene/ pyromellitic anhydride	6.8×10^6	25			2:2:2:3	ZnCl ₂		55
Naphthalene/pyromellitic anhydride	1.48×10^7	23	1.05			ZnCl ₂		65
Naphthalene/terephthaloyl chloride	6.0×10^{11}	25	0.956		1:1:1	ZnCl ₂	$\rho_o = 2.5 \times 10^2$	75

Polymer Reactants	ρ ohm·cm	Temp °C	E in E/2kT	Mobility $\frac{\text{cm}^2}{\text{V} \cdot \text{sec}}$	Mole Ratio	Catalyst	Ref.
p-Naphtholbenzein/pyromellitic anhydride	3.3×10^8	25	1.02	3.22×10^{-1}	1:1:1	ZnCl ₂	55
p-Naphtholbenzein/pyrene/ pyromellitic anhydride	7.5×10^5	25			2:2:2:3	ZnCl ₂	55
α-Naphthol-phthalein/ phthalic anhydride	6.5×10^6	25	0.544		2:1:1	ZnCl ₂	75
Perylene/pyromellitic anhydride	1.25×10^5	25	0.318			ZnCl ₂	65
Phenanthrene/benzoic acid	2.4×10^5	25	0.444		1:1:1	ZnCl ₂	75
Phenanthrene/pyromellitic anhydride	2.9×10^5 3.59×10^6	25 30	0.47 0.545	8.23×10^{-3}	1:1:1	ZnCl ₂	55 65
Phenol/phthalic anhydride	1.1×10^4	25	0.638		4:3:2	ZnCl ₂	75
Picene/pyromellitic anhydride	2.35×10^5	29	0.219			ZnCl ₂	65
Pyrene/m-amenobenzoic acid	4.7×10^2	25			1:1:1	ZnCl ₂	55
Pyrene/1, 12-benzoperylene	2.8×10^4	25			1:1:1	ZnCl ₂	55
Pyrene/chloroacetic acid	5.9×10^2	25			1:1:1	ZnCl ₂	55
Pyrene/o-chlorobenzoic acid	7.3×10^2	25			1:1:1	ZnCl ₂	55
Pyrene/m-chlorobenzoic acid	1.3×10^3	25			1:1:1	ZnCl ₂	55
Pyrene/p-fluorobenzoic acid	7.8×10^4	25			1:1:1	ZnCl ₂	55
Pyrene/9-fluorene carboxylic acid	9.8×10^{11}	25			1:1:1	ZnCl ₂	55
Pyrene/gallic acid	1.3×10^7	25			1:1:1	ZnCl ₂	55
Pyrene/o-iodobenzoic acid	2.7×10^2	25			1:1:1	ZnCl ₂	55
Pyrene/p-nitrobenzoic acid	2.7×10^3	25			1:1:1	ZnCl ₂	55

Polymer Reac tants	ρ ohm.cm	Temp °C	E in E/2kT	Mobility $\frac{\text{cm}^2}{\text{V}\cdot\text{sec}}$	Mole Ratio	Catalyst	Ref.
Pyrene/pyromellitic anhydride	3.9×10^5 3.82×10^5	25	0.10 0.42	4.50×10^{-6}	1:1:1	ZnCl ₂	55 65
Pyrene/pyrene/pyromellitic anhydride	5.6×10^3	25			2:2:2:3	ZnCl ₂	55
Pyrene/syringic acid	2.2×10^7	25			1:1:1	ZnCl ₂	55
Pyrene/X anthene-10-carboxylic acid	1.5×10^7	25	0.61	2.46×10^{-3}	1:1:1	ZnCl ₂	$\rho_0 = 7.6 \times 10^{-1}$ 55
Pyromellitic anhydride/chloroacetic acid	4.00×10^2					ZnCl ₂	65
Pyromellitic anhydride/quinizarin	8.2×10^5	25	0.41	4.53×10^{-8}		ZnCl ₂	$\rho_0 = 5.2 \times 10^2$ 55
Pyromellitic anhydride/quinoxaline	5.6×10^6	25	0.80	5.58×10^{-7}		ZnCl ₂	$\rho_0 = 9.2 \times 10^{-1}$ 55
Pyromellitic anhydride/terphenyl	1.05×10^8	25	0.820			ZnCl ₂	65
Tetracene/phthalic anhydride	9.27×10^6 7.50×10^9	25	0.657		1:1:1	AlCl ₃	$\rho_0 = 80.4$ 32
Tetracene/pyromellitic anhydride	3.95×10^5	25	0.557		1:1:1	Al Cl ₃	32
Violanthrone/pyromellitic anhydride	5.9×10^3	25	0.09	2.44×10^{-4}	1:1:1	Zn Cl ₂	$\rho_0 = 1.0 \times 10^3$ 55
Violanthrone/pyrene/pyromellitic anhydride	2.8×10^3	25	0.10	6.28×10^{-4}	1:1:1:1.5	ZnCl ₂	$\rho_0 = 3.7 \times 10^2$ 55

TABLE 6
LONG CHAIN COMPOUNDS AND POLYMERS

Substance	ρ ohm-cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Acetylferrocene polymer	10^7	50	0.31-0.47		236
Anthracene polymer reactant	1.66×10^8	25	0.771	ZnCl ₂ catalyst (1:1)	32
Benzothiadiazole	3.3×10^{11}	25	2.6	$\rho_0 = 9.84 \times 10^2$, ZnCl ₂ catalyst	71
Benzoselenodiazole	1.6×10^{14}	25	2.8		71
2,2'-Bisbenzimidazole	1.6×10^{17}	25	1.92		71
5,5-Bibenzoselenodiazole	5×10^{16}	25	1.54		71
1,3-Bis-(2-benzimidazolyl) benzene	1×10^{17}	25	1.76		71
1,4-Bis(2-benzimidazolyl)benzene	5×10^{16}	25	1.56		71
β, β' -Bis-(2-benzimidazolyl)- 1,4-divinylbenzene	2.5×10^{13}	25	1.18		71
Bromodihydropolycyclopentadiene	10^6				154
Carbazole-tetralone polymer reactant	7.5×10^3				32
Cu-Phthalocyanine polymers	20 to 100	27			284
Cu-imidazole polymer	$> 10^{15}$				142
Co-imidazole polymer	10^{17}	114		$\rho = 10^{15}$ at 150°C	286
1,5-Diformyl-2,6-dihydroxy- naphthalene oxime, metal polymers (Pd) (Cu) (Ni)	10^6 10^4 - 10^5 10^4 - 10^5	-78 to 78	0.48 0.46 0.46	Mobility: high	95, 96

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
2,5-dihydroxy-p-benzo- quinato Cu(II)	10^{10} dc 10^7 ac	100			28
1,6-Dihydroxyphenazinato- Cu(II)	10^{13} dc 10^7 ac	60 to 160 60	2 2	No hysteresis with pressure	28
Diketopiperazine	1.3×10^{10}		2.19		142
Diphenylamine polymers	$10^8 - 10^{10}$		0.8 to 1.1		142
Ferrocene-acetone polymer	6.7×10^{14}	50	0.83	7-butyl peroxide catalyst	237
Ferrocene-benzal copolymer	$10^7 - 10^8$				121, 118
Ferrocene, α -bromo-naphthalene polymer	4×10^{11} to 3.5×10^9	50	0.47 to 0.3	ρ vs various ratios of reactants	237
Ferrocene-carbonyl copolymer	$10^3 - 10^{12}$				118
Ferrocene, 1,1'-diacetyl polymer	3.6×10^9	50	1.45 to 0.42		237
Ferrocene, 1,1'-diacetyl polymer	10^5 to 10^{10}		0.05 to 0.4		237
Ferrocene, m-dichloro-benzene polymer	4×10^{11} to 3.5×10^9	50	0.47 to 0.3	ρ vs various ratios of reactants	237
Ferrocene polymers (polyketones)	$10^3 - 10^{11}$		>0.9		99, 121, 281 276
Ferrocenyl acetate polymer	3.6×10^9	50			110
FeCl ₂ polymer of chloranil: o-phenylenediamine	$<3.8 \times 10^{14}$	20 to 250			
Furan, pyrrole	7.9×10^{10}	25	1.488	$\rho_0 = 8.08 \times 10^{-2}$ ohm cm	32

Substance	ρ ohm-cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Fumaronitrile, pyrolyzed	6.3×10^1		0.22		284
Graphite	0.0285	15			69, 245
Graphites, pyrolytic	500-3500	-13 to 800	0.09	+ or - f(temp)	122
Indole, tetralone polymer	8.80×10^3				32
3-(4'-isopropylphenyl)-benzo- quinoline	1.4×10^{13}				235
Malonitrile polymer	10^{11}	20			236
2-(2'-methyl-5'-isopropyl-phenyl) quinoline	3.2×10^9				235
1-methyl-2-picolinium polyiodide	10^7-10^{10}	20 to 100	1.5 to 2.2		142
1-methylquinolinium polyiodide	10^7-10^{10}	20 to 100	2	+	142
2- β -naphthylbenzimidazole	1.4×10^{15}	25	1.32		71
2- α -Naphthylbenzimidazole	2.5×10^{15}	25	1.44		71
2,2'-Di- β -naphthyl-5,5'- bibenzimidazole	2.5×10^{14}	25	0.62		71
2,3-naphthoselenodiazole	2.5×10^7	25	2.0		71
1,2-Naphthothiadiazole	3.3×10^{20}	25	8.0		71
2,3-Naphthothiadiazole	3.3×10^{13}	25	5.2		71
Naphthalene, polymer reactant	1.31×10^{11}				32
1,4-naphthazuinone, p-toluene disocyanate polymer	1.19×10^{11}	23	2.00		65

$\Delta H_f^0 = 0.00, \Delta G_f^0 = 0.00, S^0 = 1.3909,$
 $C_p = 2.066$ at 25°C
 Mobility $1-10 \text{ cm}^2/\text{V}\cdot\text{sec}$

Substance	ρ ohm-cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Naphthylenediamine polymer	10 ¹⁰ -10 ¹³	20			273
Neoformazan	10 ¹³ to 10 ¹⁴		4.87		119, 63
Nylon (fully hydrated)	10 ⁸				142
Nylon 6-10	10 ⁸	400	2 to 4		155
Nylon 66 (theoretical value as single crystal)	8.4		2		
N-methylated nylon 10-10	1.5x10 ¹⁰	-20 to 60	2.5		7
Pyrolyzed phenol formaldehyde cation exchanger with Na Mg Al Metal-free	10 ⁻⁵ to 10 ⁻¹ 10 ⁸ to 10 ⁻² 10 ⁷ to 10 ⁻² 10 ⁸ to 10 ⁻²			+	123
Perylene-polymer	1.22x10 ⁷			+	123
Phenolphthalein polymer	4.7x10 ⁸	25		+	123
3-Phenyl-benzo-quinoline	8.7x10 ¹²			+	32
1-Phenyl-2-butyl-naphthalene	3.5x10 ¹²			+	75
1-Phenyl-2-dodecyl-naphthalene	2.7x10 ¹²			+	235
2-phenyl-5-methylbenzimidazole	5x10 ¹⁵	25	2.46		235
Phosphonitrile chloride trimer	10 ¹³ -10 ¹⁵				71
Phthalocyanine polymers	> 1000		0.6		278
					124
					284

$\rho_0 = 2.7 \times 10^{-25}$

Elastic constant 0.012×10^{12}
dyne cm²
Ref. 246: $-\Delta H_{comb}^{20^\circ} = 1715.7$

$\rho_0 = 2.49 \times 10^2$ ohm-cm ; AlCl₃
catalyst, mole ratio 1:0:1

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Polyacenaphthylene: tet ra- cyanoethylene; atactic	10^9		0.65	+	142
Polyacenequinones	10^4 to 10^{10}	60 to 280	0.26 to 1.8	+	121
Polyacety ferrocene	8.1×10^{11}	50	0.67		237
Polyacetylene	4.2×10^5		0.46		97
Polyacetylene	3×10^{13}				142
Polyacetylenes, crystalline	10^5 to 10^8 1.4×10^4		0.45 0.46		97
Polyacetylene, amorphous	10^9 to 10^{12}		0.46		97
Polyacrylonitrile	5×10^8	400	0.64		263
Polyacrylonitrile, pyro polymer, CuCl ₂ -impregnated	100	300			125
Polyacrylonitrile pyro polymer	10^{13}	28 to 120 120 to 169	1.2 1.8		142
Polyacrylonitrile, pyrolyzed	1.30 mean range to 10^{12}	-65 to 140	0.21 mean range	-	127 126
Polyamides (nylon)	10^8 to 10^{10}	400	2 to 3		142
Polyanthracene	8.3×10^5		0.26		111
Polyazochlorophenylene	10^{14}	50 to 110	5.2		156
Polyazofluorine	1.3×10^{12}	50 to 110	3.6		142
Polyazomethoxyphenylene	7×10^{13}	50 to 110	2.4		156
Polyazonitrophenylene	2×10^{14}	50 to 110	5.0		156

Mobility: $< 1 \times 10^{-2} \text{ cm}^2/\text{V} \cdot \text{sec}$

Substance	ρ ohm-cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Polyazophenylenes	1 to 2.5×10^2	120 to 150	1.24 to 1.92		128, 129
Polyazophenylene	5×10^{11}	50 to 110	3.6		156
Poly(azophenylether)	2×10^{14}	50 to 110	4.4		156
Poly (azophenyl sulfide)	10^{15}	50 to 110	5.2		156
Poly (azophenyl sulfone)	1.5×10^{14}	50 to 110	4.4		156
Polyazostilbene	2.5×10^{13}	50 to 110	3.6		156
Polybenzenes from hexachloro- benzene	0.2 to 25				104
Polybenzenes from trichloro- benzene	10^3 - 10^4				104
Polybenzimidazoles	4×10^{10} to 10^{16} at 1800 atm		1.12 to 2.23 at 1800 atm		75, 138, 157
Polybutadiene (glow-discharge polymerized)	10^{12} to 10^{15}		0.29 to 1.8		142
Poly-Cu-phthalocyanine	40	25 to 300	0.26	+	94
Poly-Cu-phthalocyanine, heat treated	4	50 to 400	0.12	+	94
Poly-Cu-tetracyanoethylene	3.0		0.12		287
Polydehydrocondensation products of bis-acetylenes	10^{14}	20 to 800	1.2 to 1.8		158
Polydibenzpyrene	950	25 to 100	0.206	-	111
Polydiketone	10^4				118

Ref. 287: $\rho = 3.8 \times 10^{-1}$
Mobility: $10 \text{ cm}^2/\text{V} \cdot \text{sec}$

Ref. 287: $\rho = 1.35 \times 10^{-2}$
Mobility: $2.5 \text{ cm}^2/\text{V} \cdot \text{sec}$

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Polyethylen DFD 4400	5×10^{18}		3.05		234
Polyethylen β -irradiated: pyrolyzed	10^9		0.64	+	142
Polyethylen β -irradiated: complex with I_2	2500		0.02		130
Polyimidazoles, pyrolyzed	2				105
Polyisobutyl ferrocenylene	2.7×10^{11}	50	0.45		237
Polymer carbon Ni doped (pyrolyzed ion exchange resins)	0.348 to 0.00418	98 to -55	0.065 to 0		131, 132
Polymer, N-substituted dithiocarbamate	$\geq 1.5 \times 10^{10}$	17 to 152	0.36 to 0.72		142
Polymer, dithioxamide (Co) (Cu)	10^{15} 2.5×10^7	127 to 227 17 to 77	0.7 0.6		142 142
Polymer, dithioxamide (Ni)	5×10^{10}	17 to 227	0.6		142
Polymeric phthalocyanines	10^7 to 10^{11}				142
Polymers, thiocyanate	$\sim 10^{12}$		0.58 to 0.76		142
Polymer, thiophene	10^{15}		1.2	-	159
Polymer, thioacetamide	10^{15}	25 to 175	2.0		159
Polymer, pyrrole	10^{15}		1.3		159
Polymer, pyrazole	10^{14}		1.4		159
Polymeric condensation product of phthalic anhydride and hydroquinone	10^5 to 10^6		0.6 to 0.8		133

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Polymeric product of tetra- cyanoethylene with metals or metal compounds at 160 to 300°C	100		0.21 to 0.26		134
Polymeric Schiff bases	10 ⁷ to 10 ¹¹	25			
Polynaphthalene	9.7x10 ⁶	25 to 100	0.32		269
Poly [N-N'-(p-p'-oxidiphenylene) pyromellitimide]	0.05		2.2±0.26	+	160
Polypentene -1	3x10 ⁹	10-15			135
Polyphenanthrene	10 ⁵		0.2		75
Polyphenyl	10 ¹⁰ to 10 ¹¹			+	111
Polyphenylacetylene	4.8x10 ¹⁰	25	0.432		121, 118
Polyphenylene	10 ¹¹ > 10 ¹⁵	25 to 90			75, 58
Poly-p-phenylene	> 10 ¹⁵			+	116
Poly-p-phenylene-iodide	2.5x10 ⁴		0.87		142
Polypropyne	10 ¹¹		0.65		288
Polyphenyltriazine	6.2		0.72		157, 75, 138,
Polypyrene	10 ⁴	25 to 100	0.16 to 0.2	+	287
Polypyridines, substituted	0.03 to 15				111
					105

Insoluble and infusible
Ref. 292: $\rho = 2.5 \times 10^7$ to 10^{16}

$\rho_0 = 7.94 \times 10^6$ ohm·cm;
Ref. 79: $\rho = 10^{16}$

Mobility: $0.1 \text{ cm}^2/\text{V}\cdot\text{sec}$

Mobility: $0.04 \text{ cm}^2/\text{V}\cdot\text{sec}$

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Poly- β -pyridylacetylene	$10^{12}-10^{13}$	25	2.50		79
Poly (quinone imines)	2.5×10^5				290
Poly-Schiff bases (p-pyrenylene- diamine-benzyl polycondensate	3×10^{11}	21 to 75 90-115 60-90	2.8 1.08 0.45	$\rho_o = 1.2 \times 10^3$ $\rho_o = 2.5 \times 10^7$	290 274
Polystyrene (tablet)	5×10^3		1.3		262
Polystyrene-AgClO ₄ atactic	4×10^8		1.48		120, 34
Polystyrol	10^9	20 to 60	0.8		83
Polysulfur-anthracene	330				104
Polysulfur nitride	0.6167 to 0.0394	0	<0.04	-	136
Polyterephthalonitrile	2.1×10^{10}		0.622	$\rho_o = 4.20 \times 10^4$ ohm cm	59
Polytetrachlorophenyl-thioether	1 to 10^7				119, 121
Polytetrachlorothiophenol	3.38×10^6				65
Polytetracyanoethylene-Cu film	10(highest)		0.1 to 0.5		297
Poly-s-triazine			1.081	$\rho_o = 1.25 \times 10^4$ heating cycle; $\rho_o = 5.22 \times 10^2$ cooling cycle	59
Polytriphenylmethane	5.8×10^{11}	25 to 100	0.42		142
Polyvinylalcohol, pyrolyzed	10^5 to 10^{13}		0.3 to 0.5		137
Polyvinylalcohol: metal chelates	$> 10^{13}$		1.2 to 3.3		137
Polyvinylanthracene: 9-Vinyl	10^{15}		1.59		142

Substance	ρ ohm-cm	Temp $^{\circ}\text{C}$	E in $E/2kT$	Sign of Major- ity Carrier	Ref.
Polyvinylanthracene: 9-Vinyl/ I_2 (1:7)	2.1×10^6		1.02		142
Polyvinylanthracene: 9-Vinyl/ I_2 (1:2.8)	3.7×10^6		1.03		142
Polyvinylanthracene-Iodine	10^5 at 57000 atm	38 to 80	0.8		138
Polyvinylanthracene- I_2 complex (polymer)	3.1 to 7.9×10^4 at 57000 atm				139
Polyvinylcarbazole	10^{17}	10 to 127			
Poly (N-vinyl) carbazole: Tetracyanoquinodimethane	10^{14} - 10^{16}	10 to 127	1.1-1.5		142
Polyvinylchloride, pyrolyzed	$>> 10^5$				142
Polyvinylchloride (chlorinated), pyrolyzed	1.4×10^7 $>> 10^5$		0.4		263
Polyvinylene	10^{11}	25 to 90			142
Polyvinylene	10^7	25 to 90	1.06		116
Polyvinylmesitylene	10^{13}				116
Poly-N-vinyl-5-methyl-2- oxazolidinone	$> 10^{14}$				120, 34
Poly-N-vinyl-5-methyl-2- oxazolidinone complexed with resorcinol	10^{14}				118
					118

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Poly-N-vinyl-5-methyl-2-oxazolidinone complexed with p-quinone	10^{14}				118
complexed with Iodine	4.5×10^6				118
Polyvinyl-naphthalene	10^{13}				120
Polyvinyl-naphthalene-2,3-dichloro-5,6-dicyano-p-benzoquinone	10^{13}				120
Polyvinyl-naphthalene-tetracyanoethylene	3×10^4		1.20	+	120
Poly(2-vinylpyridine)-I ₂ complex (5:3)	10^4				116
Poly(4-vinyl)pyridine:I ₂	10^4				116
Polyvinylpyridinium: tetra-cyanoquinodimethane derivatives	$>10^6$				142
2-(4'-propylphenyl)-3-ethyl-quinoline	3.1×10^9				235
Pyrene-polymer reactant	3.55×10^7	25	0.952		32
Pyromellitonitrile, H ₂ S reaction product (polymeric, pyrolyzed)	38.6 to 55 8.0	85	0.72	-	98 287
Pyromellitonitrile, NH ₃	14 to 1.5×10^{-3}		0.32-0.84		287
Pyromellitonitrile, methanol reaction product (polymeric, pyrolyzed)	5.4 at 92.6°C 33 2.8×10^{-3}	70 to 227 20 to 70	0.30 1.2 0.98 0.50	+ -	98 287 287
			Cooling and heating		
			After heating to 500°C		

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Pyrophyllite (lava)	109 to 10 ¹⁴	25			73
Pyrrole, p-benzoquinone polymer	3.03x10 ⁵	25	0.641		32
Pyrrole, Tetralone polymer	4.95x10 ¹⁰				
Rubeanato - Cu(II)	5x10 ⁴ ac	-10 to 80	0.4		32
	2.5x10 ⁵ dc	-10 to 80	0.3		28
Terephthalate polyesters (unoriented)	10 ⁸ to 10 ¹³				142
Tetracene, anthraquinone polymer	5.11x10 ⁷	25	0.798		32
Tetracyanoethylene: Metal polymeric chelates Reaction time: A 20 hrs B 20 hrs	(A) 0.045 (B) 8600	-80 to 160 -80 to 160	0.06 0.48	+ -	103 103
Tetracyanoethylene polymer	10 ⁸	-100 to 300	1.68	+	142
Tetramethylammonium - polyiodide	10 ⁸	20 to 100	1.5	+	142, 161
2-0-tolybenzimidazole	2.5x10 ⁵	25	1.52		71
2-p-tolylbenzimidazole	1x10 ⁶	25	1.42		71
2-m-tolylbenzimidazole	1x10 ⁷	25	1.76		71
2,4,5-trilodoimidazole polymers	1.3x10 ⁶				105
1,3,5-trinitrobenzene/I ₂ polymer	1.2x10 ¹³		1.03		142

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Triphenylammonium - polyiodide	10 ⁷ to 10 ¹⁰	20 to 100	1.4 to 2.0		161, 142
Triphthaloylbenzene	3.3x10 ¹⁴	25	1.06		71
Triphenodioxazine	1.3x10 ¹⁷	25	1.68		71
1,3,5-Tris-(2-benzimidazolyl) benzene	1.6x10 ¹⁷	25	1.58		71
Tris(x-ethylphenyl)- cyanelurine	8x10 ⁶				235
2,4,6-Tris(x-ethylphenyl)-s- triazine	2.4x10 ¹³				235
2-Undecyl-quinoline	2.0x10 ⁹	20 to 100	1.4 to 2.0	+	235
Xanthene polymer	7x72x 10 ³	20 to 250	0.46	+	112
Zn-imidazole polymer	10 ¹⁵	140			286

TABLE 7

ORGANIC DYES

Substance	ρ ohm-cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Acid Blue 83(CI No. 42660)	3×10^{10}	20	1.67		213, 279
Capri Blue	10^{15}	49	1.67		214
Crystal Violet	10^{10}	-30 to 70	0.74 1.48	- +&-	145 261, 255
Crystal Violet - Cl	10^{10}	~84	~1.2 to 1.4	-	213, 214, 144
Crystal Violet - Sulfate	10^8			-	215, 144
Crystalline Violet	$\sim 10^{10}$	70	1.78		204
Cynanthrone +	1.2×10^7 10^6	33 to 127	0.2 0.2		191, 220
Flavanthrone +	1.4×10^{11}	33 to 127	0.70		142
Fluorescein · Na-	10^{13}	-50 to 150	2.03		213
Gelatin Dye Complexes: Basic Fuchsia	10^{20}	90 to 123	2.0 ± 0.2		77, 211, 213 211
Chlorophyll	10^{22}	100 to 123	2.8 ± 0.4 $3.4 \pm .2$		211
Crystal Violet	4×10^{20}	100 to 115 115 to 140	2.4 ± 0.4 3.0 ± 0.2		211

Substance	ρ ohm-cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Gelatin Dye Complexes, continued:					
Methylene Blue	4×10^{14}	40 to 95	1.3 2.10		211 261
Rhodamine B	2×10^{18}	40 to 95	2.3 ± 0.1	+ & - (Ref. 255)	211
Riboflavin	10^{20}	105 to 119	2.1 ± 0.1		211
	$> 5 \times 10^{12}$	119 to 140	2.9 ± 0.1		211
					212
Indanthrazine +	1.4×10^{15}	33 to 127	0.66		142
Indanthrone +	7.5×10^{14}	33 to 127	0.63		142
Indanthrone Black +	2.5×10^8	33 to 127	0.56		144 191, 77
Indigo	10^{13}	-50 to 150 40 to 110	1.75 1.75		77 213
Malachite Green	10^{11}		1.54		215, 77
Malachite Green - Chloride	10^{11}			-	142
Malachite Green solid				+ & -	255
Solutions	$\sim 10^{17}$		0.05	-	216
Nacrosol Black +	10^7 10^{11}	30 to 140 30 to 140	0.8 1.6		194 194
Orthochrome T	10^{13}		2.05		219
Orthochrome T+	$> 10^{15}$	40 to 100	2.05 ± 0.1	+	219
Pinacyanol +	10^{15}	40 to 100	1.8 ± 0.1	-	219, 220
5,6-(N)-pyridino- 1,9-benzathrone +	8.5×10^{22}	33 to 170	3.20		142

Ref. 191: $\rho_0 = 3.5 \times 10^3$

at 10^{-4} - 10^{-5} mm press.

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Rhodamine B +		60 to 10 10 to -54	1.6 0.32	-	142
Rhodamine B	10^{12}	< 60	1.2	-	215, 142
				+ & -	255

Mobility: 3×10^{-2} cm²/V·sec

Mobility: 1 cm²/V·sec

TABLE 8

BIOLOGICAL MATERIALS

Substance	ρ ohm-cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Adenine	1.7×10^{16}	120	2.4		Ref.289: specific conductance = 3, 217 E = 2.6 e.v. m.p. 360-5°C
Adenine phosphate	$\sim 10^{15}$		2.0		221
Adenosine	$\sim 10^{15}$		4.5		221
Adenosine triphosphate (ATP)	$\sim 10^{15}$		2.0		221
Adenylic acid, yeast	$\sim 10^{15}$		1.8		221
Adenylic acid, muscle	$\sim 10^{15}$		2.0		221
Acetioporphyrin -1	3.31×10^{13}	100 to 370	1.99@127°		218
Acetioporphyrin -1, Co	1.66×10^{11}	180 to 40	1.87@127°		218
Acetioporphyrin -1, Cu	3.47×10^{11}	160 to 45	1.82@127°		218
Acetioporphyrin-1, Mg	1.45×10^{13}		1.86@127°		218
Acetioporphyrin-1, Ni	7.76×10^{11}	170 to 45	1.81@127°		218
α -Alanine	5.3×10^{14}	127	3.31		222
	5.3×10^{14}	127	2.16		m.p. 297°C d.
β -Alanine	5.3×10^{12}	127	4.07		222
Albumen, serum	$> 10^{10}$				142
28% water	10^5				
Albumen	10^{16} to 10^{17}	40 to 100	2.26		223, 211
Bovine Plasma albumen	7.9×10^{11}	127	2.78		224
Collagen	2.9×10^{13}	117	2.73		224

Ref.293: elastic modulus =
 2×10^6 dynes/cm²

Substance	ρ ohm-cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Coproporphyrin - III	5.0x10 ¹¹	127	1.91		218
Cytidilic acid	~10 ¹⁵		2.2		142
Cytidine	10 ¹¹ to 10 ¹³		4.9		221
Cytochrome C	3.8x10 ¹¹	127	2.60		224
Cytosine	3.5x10 ¹⁴	120	2.4		217
DNA					
(dried)	5x10 ¹¹	170 to 60	2.42±0.5		288
(calf thymus)	2x10 ⁴ ac	127	2.42		288
	10 ¹⁶	20 to 95	1.7		218
Na salt, native	10 ¹¹	20 to 50	1.52		142
Na salt, denatured	10 ¹³	20 to 50	1.52		225
Na salt, heat treated	10 ¹²	20 to 50	1.70		225
Mg salt	10 ¹⁵	20 to 50	1 to 1.4		225
Diketopiperazine	1.3x10 ¹⁰	> 157	2.13		222
Dioxyribonucleic acid	10 ¹³	90	2.44 and 1.90±0.4 ev		275, 280
			$\rho_0 = 1.6 \times 10^{-3}$		
Elastin	2.0x10 ¹⁴	127			224
Fibrinogen	6.2x10 ¹¹	127	2.69		224
Gelatin (fully hydrated)	10 ⁹ 2x10 ²³	110 to 140	2.96		142
				$\rho_0 = 10^8$ ohm cm	
				Ref. 228: E=2.2; Ref. 250: heat of solution 23.24±0.25 cal/g Ref. 251: energy of activation for removal of H ₂ O, 1.6 kcal/mole (100-200°C) HAc treated, 0.46 kcal/mole untreated	

Substance	ρ ohm-cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Gelatin (fully hydrated), continued: (completely dry)	1.25x10 ¹⁸ 4.7x10 ¹³	117	3.05		142 224
Globin	4.5x10 ¹³	100 to 160	2.97@127°C		222
Glycine (single crystal) ↓ ac	6.4x10 ¹³	127 to 155	3.2		222
(single crystal) ↓ ac	6.4x10 ¹³	90 to 127	2.67		222
(single crystal) ac	1.8x10 ¹³	127 to 155	2.82		222
(single crystal) ac	1.8x10 ¹³	90 to 127	1.99		222
(compressed powder)	1.7x10 ¹²		2.92		222
Glycine - Cu chelate	10 ¹⁵	127			222
Guanine	1.2x10 ¹⁶	120	2.6		217
				Ref. 289: specific conductance = 0.003, m.p. 360°C d., E = 1.96 e. V.	
Guanylic acid	~10 ¹⁵		1.5	m.p. 280°C d.	221
Guanosine	10 ¹¹ to 10 ¹²		2.1	m.p. 208°C d.	221
Hematin	1.3x10 ¹²	20 to 180	1.74@127°C	m.p. > 200°C	222
Hemoglobin (denatured)	10 ⁸	2.89			226, 224
Heme, ferric	4.6x10 ¹²	84 to 140	2.75@127°C +	Ref. 228 for bovine hemoglobin	222
Hemoglobin (natural)	1.32x10 ¹²	127	1.80		173
	5.4x10 ¹¹	117	2.66	Ref. 258: dipole moment = 380D Dielectric relaxation time T ₀ = 1.45x10 ⁻⁸ sec	224
(denatured)	1.1x10 ¹²	117	2.89		224
Insulin, pig	3.2x10 ¹²	117	2.91		224
	7.3x10 ¹⁴	120 to 200	3.13		224

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Keratin	10 ⁸				142
Lysozyme	3.9x10 ¹¹	127	2.62		224
Melanin from Japanese squid	3x10 ¹⁰			-	84
Oxamide	2.7x10 ¹⁵		1.87		222
Plasma albumen (dry)			2.2		144
(moist)			1.6		81
Plasma, bovine	8x10 ¹⁷		2.80		227
(chloranil complex)	3x10 ¹²		1.06		227
Polyglycine	1.6x10 ¹³	117	2.99		224
	2.0x10 ¹³	127	3.12		222
Poly-L-tyrosine, helical	1.6x10 ¹²	117	2.99		224
random coil	4.7x10 ¹²	117	2.98		224
Protein, dry	10 ¹⁸			+and-	142
RNA, yeast	3.02x10 ¹¹	170 to 60	2.42±0.05		218
Riboflavin	10 ¹⁴		2.4		221
Thrombin	2.6x10 ¹¹	127	2.59		224
Thymidine	10 ¹¹ to 10 ¹³		4.7		221
				Ref. 289: specific conductance = 0.25, E=2.4 e.V. m.p. 185°C	
Thymine	9x10 ¹⁴	120	1.96		217
			2.4		289
Thymus nucleoprotein	6.2x10 ¹¹	127	2.57		224
Tobacco mosaic virus	1.1x10 ¹³	127	2.92		224

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Tyrosine (DL)	1.1×10^{15}	127	2.2		222
Uracil	8.5×10^{15}	120	2.72		222
Uridine	10^{11} to 10^{13}		5.2		221

m.p. 316-200°C d.
 Ref. 289: Specific conductance = 30; 217
 E = 2.72 e.v.; m p. 338°C
 m.p. 164-5°C

TABLE 9

LIQUIDS AND GLASSES

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
Benzene	104	17 to 60	1.16 to 0.84±0.08	saturated with air Ref. 253: electron affinity (PhCl=1) =0.01	77 77 142
	1.45x10 ¹⁴			m.p. 5.5°C	142
	1.64x10 ¹⁵			saturated with air in N ₂ $\Delta H_{298} = +11,630$ cal., $\Delta S_{298} = -59.6$ e.w., $\Delta G_{298} = 29,400$	142 244
Chlorpromazine	10 ⁻²	32	2.1	+2, large space charges m.p. 59-60°C	186
1,3-Cyclohexadiene	1.5x10 ¹⁴	20 to 65	1.5x10 ¹⁴		233
1,4-Cyclohexadiene	2x10 ¹⁶	20 to 65	0.84		233
Cyclohexane	> 10 ¹⁶ 1.2x10 ¹⁵	20 to 65 5 to 72	0.32 1.9	m.p. 6.5°C saturated with water at the freezing point	233 233
	→ ∞	0			233
Cyclohexene	6.7x10 ¹⁴	20 to 65	0.84	m.p. -103.50°C	233
Dimethylbenzene	1.5x10 ¹⁵		0.82		233
n-Heptane	> 10 ¹⁰	20 to 65	0.30		233, 142
n-Hexane	10 ¹⁶ to 10 ¹⁷		0.32	Mobility: 1.4±0.1x10 ⁻³ cm ² /V·sec	233, 142
Methylcyclohexane	> 10 ¹⁶	20 to 65	0.32		233
Salanil	2.8x10 ⁸		0.8		92
Toluene	1.25x10 ¹⁴		0.82	m.p. -95°C	233
1,2,4-Trimethylbenzene	1.15x10 ¹⁵		0.84		233
1,3,5-Trimethylbenzene	10 ¹⁶		0.38		233
m-xylene			0.82	$\rho_o = 1 \times 10^8$ ohm cm $\Delta H_{298} = -4,670$ cal., $\Delta S_{298} = 0.106.3$ e.w., $\Delta G_{298} = +27,000$ cal	77 244

Substance	ρ ohm·cm	Temp °C	E in E/2kT	Sign of Major- ity Carrier	Ref.
o-xylene			0.90		77
				$\rho_o = 3 \times 10^9$ ohm cm	244
p-Xylene				$\Delta H_{298} = -4,670$ cal., $\Delta S_{298} = -107.3$ e.w., $\Delta G_{298} = +27,300$ cal	77
			0.82	$\rho_o = 1 \times 10^8$ ohm cm	
Zn-9-anthrate	$\Delta H_{298} = -8,470$ cal., $\Delta S_{298} = -106.1$ e.w., $\Delta G_{298} = +23,200$ cal 10 ¹⁴ to 10 ¹⁷				142
+					
In the following, conductivity was found to depend on temperature exponentially. Samples were examined as solids and as liquids.					
Acridine	10 ¹³ to 10 ²²	25			300
Anthracene	10 ¹³ to 10 ²²	25			300
Benzanthrone	10 ¹³ to 10 ²²	25			300
β -Methylnaphthalene	10 ¹³ to 10 ²²	25			300
Naphthalene	10 ¹³ to 10 ²²	25			300
α -Naphthol	10 ¹³ to 10 ²²	25			300
β -Naphthol	10 ¹³ to 10 ²²	25			300
α -Naphthoquinoline	10 ¹³ to 10 ²²	25			300
β -Naphthoquinoline	10 ¹³ to 10 ²²	25			300
Phenanthrene	10 ¹³ to 10 ²²	25			300
o-Phenanthroline	10 ¹³ to 10 ²²	25			300
Phenazine	10 ¹³ to 10 ²²	25			300
1-Phenylazo-2-naphthol	10 ¹³ to 10 ²²	25			300
1-(o-Tolylazo)-2-naphthol	10 ¹³ to 10 ²²	25			300

TABLE 10
PHYSICAL PROPERTIES OF COMMERCIALY AVAILABLE PLASTICS

FROM REFERENCE 242:

PHYSICAL PROPERTIES OF COMMERCIALY AVAILABLE PLASTICS
ABS (ACRYLONITRILE - BUTADIENE - STYRENE)

Properties	Extrusion Grade	High Impact	High Heat Resistance	Medium Impact
Specific gravity	0.99 to 1.15	1.02 to 1.2	1.03 to 1.2	1.02 to 1.2
Specific volume, cu.in/lb.	24 to 28	-	23 to 27	-
Refractive index, n_D	-	-	-	-
Tensile strength, psi	2400 to 6500	4500 to 7000	6000 to 7500	5500 to 7000
Elongation, %	-	-	-	-
Tensile modulus, 10^5 psi	1 to 3.3	2 to 3.5	3 to 4	2.8 to 4
Compressive strength, $\text{psi} \times 10^3$	2.5 to 6.5	4.5 to 7.0	6.0 to 7.5	5.5 to 7.0
Flexural strength, $\text{psi} \times 10^3$	4.0 to 10.0	7.0 to 10.5	9.0 to 12.0	8.0 to 11.0
Impact strength, ft.-lb/in.	1.8 to 10	3 to 7	1 to 4.5	0.7 to 2.5
Hardness, Rockwell	30 to 105	80 to 110	100 to 120	95 to 115
Thermal conductivity, 10^{-4} cal. / sec./sq.cm., /($^{\circ}\text{C.}/\text{cm}$)	4.6 to 8	4.6 to 8	4.6 to 8	4.6 to 8
Specific heat, cal./ $^{\circ}\text{C}$ per gm.	0.3 to 0.4	0.3 to 0.4	0.3 to 0.4	0.3 to 0.4
Thermal expansion, 10^{-3} per $^{\circ}\text{C}$	9 to 13	9 to 11	5.5 to 8.5	7.5 to 9
Resistance to heat, $^{\circ}\text{F.}$ (continuous)	140 to 200	170 to 210	190 to 230	160 to 200
Deflection temp., $^{\circ}\text{F}$ @ 264 psi fiber stress	140 to 200	175 to 210	195 to 230	175 to 200
@ 66 psi fiber stress	190 to 215	190 to 215	215 to 245	190 to 210

Volume resistivity, ohm-cm.	0.5x10 ¹³ - 4x10 ¹⁶	1-4x10 ¹⁶	1.5x10 ¹⁶	1.5-4x10 ¹⁶
Dielectric strength (short time) volts/mil	400 to 550	400 to 550	400 to 550	400 to 550
(step-by-step) volts/mil	350 to 500	350 to 500	350 to 500	350 to 500
Dielectric constant, 60 cycles	2.4 to 3.4	2.4 to 3.4	2.4 to 3.4	2.4 to 3.4
10 ³ cycles	2.4 to 3.4	2.4 to 3.4	2.4 to 3.4	2.4 to 3.4
10 ⁶ cycles	2.4 to 3.4	2.4 to 3.4	2.4 to 3.4	2.4 to 3.4
Dissipation (power) factor 60 cycles	0.003-0.013	0.003-0.013	0.003-0.013	0.003-0.013
10 ³ cycles	0.003-0.013	0.003-0.013	0.003-0.013	0.003-0.013
10 ⁶ cycles	0.005-0.015	0.005-0.015	0.005-0.015	0.005-0.015
Arc resistance, sec.	55 to 90	55 to 90	55 to 90	55 to 90
Water absorption, 24 hr., %	0.25 to 0.45	0.25 to 0.45	0.25 to 0.45	0.25 to 0.45
Burning rate (flammability, in./min.)	slow	slow	slow	slow
Effect of sunlight	none	none to slightly yellow	none	none
Effect of weak acids	none	none	none	none
Effect of strong acids	none	attacked by oxidizing acids	none	none
Effect of weak alkalis	none	none	none	none
Effect of strong alkalis	none	none	none	none
Effect or organic solvents	soluble in ketones, esters, and some chlorinated hydrocarbons			
Machining qualities		good to excellent		

PROPERTIES	Acetal		Acrylic	
	Homopolymer	Copolymer	Methyl Methacrylate Cast	Molding
Specific gravity (density)	1.425	1.41	1.17-1.20	1.17-1.20
Specific volume, cu.in./lb.	19.5	19.7	23.1 to 23.7	23.1 to 23.7
Refractive index, n_D	1.48	-	1.48 to 1.50	1.49
Tensile strength, psi	10000	8800 (73°F.)	8000 to 11000	7000 to 11000
Elongation, %	15(Inj); 75(Ext)	60 to 75	2 to 7	2 to 10
Tensile modulus, 10^5 psi	4.10	4	3.5 to 5.0	4.5
Compressive strength, psi $\times 10^{-3}$	18.(10% defl)	16.(10% defl)	11. to 19.	12. to 18.
Flexural strength, psi $\times 10^{-3}$	14	13	12 to 17	13 to 17
Impact strength, ft.-lb/in.	1.4(inj); 2.3(ext)	1.2 to 1.4	0.4 to 0.5	0.3 to 0.5
Hardness, Rockwell	M94, R120	M78 to M80	M80 to M100	M85 to M105
Thermal conductivity 10^{-4} cal. / sec. / sq. cm., 1(°C. / cm)	5.5	5.5	4 to 6	4 to 6
Specific heat, cal. / °C per gm.	0.35	0.35	0.35	0.35
Thermal expansion, 10^{-3} per °C	8.1×10^{-5}	8.1×10^{-8}	5 to 9	5 to 9
Resistance to heat, °F (continuous)	195	220	140 to 200	140 to 190
Deflection temp., °F				
@ 264 psi fiber stress	255	230	160 to 215	155 to 210
@ 66 psi fiber stress	338	316	165 to 235	165 to 225

Volume resistivity, ohm-cm.	6×10^{14}	1×10^{14}	$> 10^{15}$	$> 10^{14}$
Dielectric strength (short time) volts/mil	465-1900	500 (90 mil)	450-550	450-550
(step-by-step) volts/mil	400	-	350-400	350-400
Dielectric constant, 60 cycles	-	3.8	3.5 to 4.5	3.5 to 4.5
10 ³ cycles	3.7	3.8	3.0 to 3.5	3.0 to 3.5
10 ⁶ cycles	3.7	3.8	2.2 to 3.2	2.2 to 3.2
Dissipation (power) factor 60 cycles	-	-	0.05-0.06	0.04-0.06
10 ³ cycles	0.004	0.004	0.04-0.06	0.03-0.05
10 ⁶ cycles	0.004	0.005-0.007	0.02-0.03	0.02-0.03
Arc resistance, sec.	129 on 15 mil	240 (burns)	no track	no track
Water absorption, 24 hr., %	0.25	0.22	0.3 to 0.4	0.3 to 0.4
Burning rate (flammability, in./min.)	slow (1.1)	slow (1.1)	slow (1.0-1.3)	slow (0.9-1.2)
Effect of sunlight	chalks slightly	chalks slightly	nil	nil
Effect of weak acids	resists some	resists some	nil	nil
Effect of strong acids	attacked	attacked	attacked only by high conc. oxidizing acids	
Effect of weak alkalis	resists some	none	nil	nil
Effect of strong alkalis	resists some	none	attacked	attacked
Effect of organic solvents	excellent resistance		soluble in ketones, esters, aromatic & chlorinated solvents	
Machining qualities	excellent	excellent	fair to excellent	good to excellent

PROPERTIES	Acrylic		Allyl Monomer
	Methyl Methacrylate/ styrene copolymer	Impact Acrylic Molding Compound	Cast Allyl
Specific gravity (density)	1.08-1.16	1.08-1.18	1.30-1.40
Specific volume, cu.in/lb.	23.8-25.6	23.3-25.6	19.8-20.9
Refractive index, nD	1.533-1.565	not appl.	1.50-1.575
Tensile strength, psi	9000 to 11000	5000 to 9000	5000 to 6000
Elongation, %	2 to 5	> 15 to 50	-
Tensile modulus, 10^5 psi	4.4 to 5.0	2.0 to 4.0	3.0
Compressive strength, psi $\times 10^{-3}$	11 to 15	4 to 14	21 to 23
Flexural strength, psi $\times 10^{-3}$	16 to 19	8 to 13	6 to 13
Impact strength, ft.-lb/in.	0.35 to 0.50	0.5 to 4.5	0.2 to 0.4
Hardness, Rockwell	M70 to M85	R99 to R120	M95 to R120
Thermal conductivity 10^{-4} cal. / sec./sq. cm., / $1^\circ\text{C.}/\text{cm.}$)	3.0 to 4.0	4 to 5	4.8 to 5
Specific heat, cal./ $^\circ\text{C}$ per gm.	0.34	0.34	0.26-0.55
Thermal expansion, 10^{-3} per $^\circ\text{C}$	6 to 8	6 to 8	5 to 10
Resistance to heat, $^\circ\text{F}$ (continuous)	180 to 200	160 to 185	212
Deflection temp., $^\circ\text{F}$			
@ 264 psi fiber stress	185 to 210	165 to 215	140 to 190
@ 66 psi fiber stress	-	180 to 225	-

Volume resistivity, ohm-cm.	> 10 ¹⁶	-	2.0x10 ¹⁶	> 4x10 ¹⁴
Dielectric strength (short time) volts/mil	400 to 500	475	400 to 500	380
(step-by-step) volts/mil	-	-	400 to 500	320
Dielectric constant, 60 cycles	-	3.12	3.0 to 4.0	3.45 to 5.0
10 ³ cycles	3.13	3.0	2.5 to 3.5	3.35 to 5.0
10 ⁶ cycles	2.81	3.03	2.0 to 3.0	3.6 to 4.5
Dissipation (power) factor 60 cycles	-	0.039	0.03 to 0.04	0.006-0.019
10 ³ cycles	0.025	0.028	0.02 to 0.035	0.01
10 ⁶ cycles	0.019	0.011	0.01 to 0.02	0.028-0.06
Arc resistance, sec.	-	-	no track	120 to 250
Water absorption, 24 hr., %	0.2	0.2	0.2 to 0.4	0.03 to 0.44
Burning rate (flammability, in./min.)	slow	slow(1.7)	slow (1.0 to 0.3)	0.3 to self-extinguishing
Effect of sunlight	nil	nil	sl. strength loss	yellow v. slightly
Effect of weak acids	none	nil	pract. nil	none
Effect of strong acids	-	attacked by high conc. of oxidizing acids	—	only by oxidizing acids
Effect of weak alkalis	none	nil	pract. nil	none
Effect of strong alkalis	none	nil	pract. nil	none to slight
Effect of organic solvents	soluble in ketones, esters, aromatic and chlorinated hydrocarbons			
Machining qualities	good to excellent			good

Cellulosic Molding Compound and Sheets
Ethyl Cellulose Acetate

PROPERTIES

Cellulose Molding Cpd. and Sheets

Sheet

Molding

High Acetyl

Specific Gravity (density)

1.09 to 1.17 1.28 to 1.32 1.23 to 1.34 1.26 to 1.34

Specific volume, cu. in./lb.

23.6 to 25.5 20.9 to 21.6 20.6 to 22.5 20.6 to 22.5

Refractive index, n_D

1.47 1.49 to 1.50 1.46 to 1.50 1.46 to 1.50

Tensile strength, psi

2000-8000 4500-8000 1900-8500 3000-11000

Elongation, %

5 to 40 20 to 50 6 to 70 4 to 55

Tensile modulus, 10^5 psi

1.0 to 3.0 3.4 0.65 to 4.0 3.5 to 4.5

Compressive strength, psi $\times 10^{-3}$

10 to 35 18 to 25 2.2 to 36 14 to 36

Flexural strength, psi $\times 10^{-3}$

4 to 12 6 to 10 0.2 to 16 3.5 to 13

Impact strength, ft.-lb/in.

2.0 to 8.5 1.0 to 3.0 0.4 to 5.2 0.4 to 5.2

0.3 to 1.7
-40°F

Hardness, Rockwell

R50 to R115 R95 to R120 R35 to R125 R65 to R125

Thermal conductivity 10^{-4} cal. /
sec./sq. cm., /1°C./cm.)

3.8 to 7 4 to 8 4 to 8 4 to 8

Specific heat, cal./°C per gm.

0.3 to 0.75 0.3 to 0.5 0.3 to 0.42 0.3 to 0.42

Thermal expansion, 10^{-3} per °C

10 to 20 10 to 15 8 to 16 8 to 16

Resistance to heat, °F (continuous)

115 to 185 140 to 220 140 to 220 150 to 220

Deflection temp, °F

@ 264 psi fiber stress

115 to 190 130 to 160 111 to 190 118 to 195

@ 66 psi fiber stress

- - 120 to 205 130 to 212

	10 ¹² to 10 ¹⁴	10 ¹¹ to 10 ¹³	10 ¹⁰ to 10 ¹⁴	10 ¹⁰ to 10 ¹³
Volume resistivity, ohm-cm.				
Dielectric strength (short time) volts/mil	350 to 500	250 to 300	250 to 365	250 to 365
(step-by-step) volts/mil	300 to 500	-	200 to 300	200 to 300
Dielectric constant, 60 cycles	3.0 to 4.2	4.7	3.5 to 7.5	4.7
10 ³ cycles	3.0 to 4.1	4.5	3.5 to 7.0	4.5
10 ⁶ cycles	2.8 to 3.9	4.4	3.2 to 7.0	4.4
Dissipation (power) factor 60 cycles	0.005-0.020	0.018	0.01-0.06	0.018
10 ³ cycles	0.002-0.020	0.022	0.01-0.06	0.022
10 ⁶ cycles	0.010-0.060	0.051	0.01-0.10	0.051
Arc resistance, sec.	60 to 80	180 to 200	50 to 310	50 to 310
Water absorption, 24 hr., %	0.8 to 1.8	2.0 to 4.5	1.9 to 6.5	1.3 to 2.0
Burning rate (flammability, in./min.)	slow	— slow to self-extinguishing —		
Effect of sunlight	slight	no visible change	slight	slight
Effect of weak acids	slight	no visible change	slight	none
Effect of strong acids	decomposes	decomposes	decomposes	decomposes
Effect of weak alkalis	none	no visible change	slight	no visible change
Effect of strong alkalis	slight	swells	decomposes	decomposes
Effect of organic solvents	widely soluble	soluble in liquid ketones and esters, softened or dissolved by chlorinated & aromatic hydrocarbons		
Machining qualities	good	good	excellent	good

Cellulosic Molding Compound and Sheets

Cellulose Propionate Molding Compound	Cellulose Acetate-Butyrate Sheet	Molding (Pyroxylin)	Cellulose Nitrate
1.18 to 1.24	1.15 to 1.22	1.15 to 1.22	1.35 to 1.40
22.5 to 23.4	22.7 to 24.0	22.7 to 24.0	19.8 to 20.5
1.46 to 1.49	1.46 to 1.49	1.46 to 1.49	1.49 to 1.51
2000 to 7800	2600 to 6900	2600 to 6900	7000 to 8000
29 to 100	60 to 100	40 to 88	40 to 45
0.6 to 2.15	2.0 to 2.5	0.5 to 2.0	1.9 to 2.2
3.1 to 22.0	-	2.1 to 22.0	22.0 to 35.0
3.2 to 11.4	4.0 to 9.0	1.8 to 9.3	9.0 to 11.0
0.5 to 11.5	0.8 to 6.3	0.8 to 6.3	5.0 to 7.0
R10 to R122	R30 to R115	R31 to R116	R95 to R115
4 to 8	4 to 8	4 to 8	5.5
0.3 to 0.40	0.3 to 0.4	0.3 to 0.4	0.3 to 0.4
11 to 17	11 to 17	11 to 17	8 to 12
155 to 220	140 to 220	140 to 220	ca. 140
111 to 228	113 to 202	113 to 202	140 to 160
158 to 250	130 to 227	130 to 227	-

PROPERTIES

Specific gravity (density)

Specific volume, cu. in./lb.

Refractive index, n_D

Tensile strength, psi

Elongation, %

Tensile modulus, 10^5 psi

Compressive strength, psi $\times 10^{-3}$

Flexural strength, psi $\times 10^{-3}$

Impact strength, ft.-lb/in.

Hardness, Rockwell

Thermal conductivity 10^{-4} cal. /
sec./sq. cm., / $1^\circ\text{C.}/\text{cm.}$)

Specific heat, cal./ $^\circ\text{C}$ per gm.

Thermal expansion, 10^{-3} per $^\circ\text{C}$

Resistance to heat, $^\circ\text{F}$ (continuous)

Deflection temp., $^\circ\text{F}$
@ 264 psi fiber stress

@ 66 psi fiber stress

Volume resistivity, ohm-cm.	10 ¹² to 10 ¹⁶	10 ¹¹ to 10 ¹⁵	10 ¹¹ to 10 ¹⁵	(10-15) x 10 ¹⁰
Dielectric strength (short time) volts/mil	300 to 450	250 to 400	250 to 400	300 to 600
(step-by-step) volts/mil	300 to 375	-	-	250 to 550
Dielectric constant, 60 cycles	3.7 to 4.0	4.7	3.5 to 6.4	7.0 to 7.5
10 ³ cycles	3.6 to 4.0	4.5	-	7.0
10 ⁶ cycles	3.4 to 3.6	4.4	3.2 to 6.2	6.4
Dissipation (power) factor 60 cycles	0.01 to 0.04	0.018	0.01 to 0.04	0.09 to 0.12
10 ³ cycles	0.01 to 0.04	0.022	-	0.03
10 ⁶ cycles	0.01 to 0.04	0.051	0.01 to 0.04	0.06 to 0.09
Arc resistance, sec.	175 to 190	-	-	-
Water absorption, 24 hr., %	1.2 to 2.8	0.9 to 2.2	0.9 to 2.2	1.0 to 2.0
Burning rate (flammability, in./min.)	slow (1.0 to 1.3)	slow	slow	very fast
Effect of sunlight	slight	no visible change	slight	discolors and becomes brittle
Effect of weak acids	slight	no visible change	slight	slight
Effect of strong acids	decomposes	decomposes	decomposes	decomposes
Effect of weak alkalis	slight	no visible change	slight	slight
Effect of strong alkalis	decomposes	decomposes	decomposes	decomposes
Effect on organic solvents	soluble in ketones and esters, softened or dissolved by chlorinated and aromatic hydrocarbons			widely soluble
Machining qualities	excellent	good	excellent	excellent

PROPERTIES

	Chlorinated Polyether	Epoxy Resins		
		No filler	Cast Resins Silica Filler	Flexibilized
Specific gravity (density)	1.4	1.11 to 1.40	1.6 to 2.0	1.05 to 1.35
Specific volume, cu. in/lb.	19.8	20 to 24.9	17.3 to 13.9	20.5
Refractive index, n_D	-	1.55 to 1.61	-	-
Tensile strength, psi	6000	4000-13000	7000-13000	2000-10000
Elongation, %	60 to 160	3 to 6	1 to 3	20 to 70
Tensile modulus, 10^5 psi	1.6	3.5	-	0.01 to 3.5
Compressive strength, psi $\times 10^{-3}$	-	15.0 to 25.0	15.0 to 35.0	1.0 to 14.0
Flexural strength, psi $\times 10^{-3}$	5.0	13.3 to 21.0	8.0 to 14.0	1.0 to 13.0
Impact strength, ft.-lb/in.	0.4	0.2 to 1.0	0.3 to 0.45	3.5 to 5
Hardness, Rockwell	R-100	M80 to M110	M85 to M120	-
Thermal conductivity 10^{-4} cal. / sec./sq. cm., /1(°C./cm.)	3.1	4 to 5	10 to 20	-
Specific Heat, cal./°C per gm.	-	0.25	0.20 to 0.27	-
Thermal expansion, 10^{-3} per °C	8.0	4.5 to 6.5	2.0 to 4.0	2 to 10
Resistance to heat, °F. (continuous)	290	250 to 550	250 to 550	250 to 300
Deflection temp., °F	-	115 to 550	160 to 550	RT to 250
@ 264 psi fiber stress	-	-	-	-
@ 66 psi fiber stress	285	-	-	-

	1015	1012 to 1017	1013 to 1016	1.3-15x10 ¹⁴
Volume resistivity, ohm-cm.				
Dielectric strength (short time) volts/mil	400	400 to 500	400 to 550	235 to 400
(step-by-step) volts/mil	-	380	-	235 to 400
Dielectric constant, 60 cycles	3.1	3.5 to 5.0	3.2 to 4.5	3 to 6
10 ³ cycles	3.0	3.5 to 4.5	3.2 to 4.0	3 to 5
10 ⁶ cycles	2.9	3.3 to 4.0	3.0 to 3.8	3 to 6
Dissipation (power) factor 60 cycles	0.01	0.002-0.010	0.008-0.03	0.010-0.040
10 ³ cycles	0.01	0.002-0.02	0.008-0.03	0.012-0.050
10 ⁶ cycles	0.01	0.030-0.050	0.02-0.04	0.018-0.090
Arc resistance, sec.	-	45 to 120	150 to 300	50 to 180
Water absorption, 24 hr., %	0.01	0.08-0.15	0.04-0.10	0.27-0.5
Burning rate (flammability, in./min.)	self-extinguishing	slow	self-extinguishing	slow
Effect of sunlight	slight	none	none	none
Effect of weak acids	none	none	none	none
Effect of strong acids	attacked by oxidizing acids	attacked by some	attacked by some	attacked by some
Effect of weak alkalis	none	none	none	none
Effect of strong alkalis	none	slight	slight	slight
Effect of organic solvents	resists most	—	generally resistant	—
Machining qualities	excellent	good	poor	good

PROPERTIES	Epoxy Resins		
	Molding Compounds		Encapsulating Grades
	Glass Filled	Mineral Filled	Mineral Filled Glass Filled
Specific gravity (density)	1.6 to 2.0	1.6 to 2.0	1.7 to 2.1 , 1.7 to 2
Specific volume, cu.in/lb.	14 to 15.4	13.4 to 14.2	14
Refractive index, n_D	-	-	-
Tensile strength, psi	10000-30000	5000-15000	4000-10000 5000-15000
Elongation, %	4	-	-
Tensile modulus, 10^5 psi	30.4	-	-
Compressive strength, psi $\times 10^{-3}$	25.0 to 40.0	18.0 to 40.0	18.0 to 30.0 18.0 to 30.0
Flexural strength, psi $\times 10^{-3}$	10.0 to 60.0	8.0 to 15.0	6.0 to 15.0 8.0 to 20.0
Impact strength, ft.-lb/in.	10.0	0.3 to 0.4	0.3 to 0.45 0.5 to 2.0
Hardness, Rockwell	M100 to M110	M100 to M110	M100 to M112 M100 to M112
Thermal conductivity 10^{-4} cal. / sec./sq. cm., /1(°C./cm.)	4 to 10	4 to 30	4 to 10 4 to 10
Specific heat, cal./°C per gm.	0.19	-	-
Thermal expansion, 10^{-3} per °C	1.1 to 3.5	2.0 to 5.0	3 to 6 3.5
Resistance to heat, °F. (continuous)	300 to 500	300 to 500	300 to 450 300 to 450
Deflection temp., °F	250 to 500	250 to 500	225 to 450 225 to 450
@ 264 psi fiber stress	-	-	-
@ 66 psi fiber stress	-	-	-

Volume resistivity, ohm-cm.	> 10 ¹⁴	> 10 ¹⁴	> 10 ¹⁴
Dielectric strength (short time) volts/mil	300 to 400	300 to 400	250 to 400
(step-by-step) volts/mil	300 to 400	300 to 400	250 to 400
Dielectric constant, 60 cycles	3.5 to 5.0	3.5 to 5.0	3.5 to 5.0
10 ³ cycles	3.5 to 5.0	3.5 to 5.0	3.5 to 5.0
10 ⁶ cycles	3.5 to 5.0	3.5 to 5.0	3.5 to 5.0
Dissipation (power) factor 60 cycles	0.01	0.01	0.01
10 ³ cycles	0.01	0.01	0.01
10 ⁶ cycles	0.01	0.01	0.01
Arc resistance, sec.	120 to 180	150 to 190	120 to 180+
Water absorption, 24 hr., %	0.05 to 0.2	0.04	0.03 to 0.2
Burning rate (flammability, in./min.)	— self-extinguishing —	— self-extinguishing —	— self-extinguishing —
Effect of sunlight	slight	slight	slight
Effect of weak acids	none	none	none
Effect of strong acids	negligible	none	slight
Effect of weak alkalis	none	none	slight
Effect of strong alkalis	none	slight	— slight to attack —
Effect of organic solvents	none	none	slight
Machining qualities	fair to good	fair	fair to good

PROPERTIES	Fluoroplastics			
	Polychloro- Trifluoro- Ethylene	Polytetrafluoro- ethylene Molding Compound	FEP Fluorocarbon Fluoride	Poly- vinylidene Fluoride
Specific gravity (density)	2.1 to 2.2	2.13 to 2.22	2.12 to 2.17	1.76 to 1.77
Specific volume, cu.in/lb.	12.7 to 13.2	12.6 to 13.2	12.8 to 13.0	15.6 to 15.7
Refractive index, n_D	1.425	1.35	1.338	1.42
Tensile strength, psi	4500 to 6000	2000 to 4500	2700 to 3100	7000
Elongation, %	80 to 250	200 to 400	250 to 330	100 to 300
Tensile modulus, 10^5 psi	1.5 to 3	0.58	0.5	1.2
Compressive strength, psi $\times 10^{-3}$	4.6 to 7.4	1.7	-	10.0
Flexural strength, psi $\times 10^{-3}$	7.4 to 9.3	-	-	-
Impact strength, ft.-lb/in.	2.5 to 2.7	3.0	no break	3.5
Hardness, Rockwell	R75 to R95	D50 to D65	R25	D-90(Shore)
Thermal conductivity 10^{-4} cal./ sec./sq. cm., /1(°C./cm.)	4.7 to 5.3	6	6	3
Specific heat, cal./°C per gm.	0.22	0.25	0.28	0.33
Thermal expansion, 10^{-3} per °C	4.5 to 7.0	10	8.3 to 10.5	12
Resistance to heat, °F. (continuous)	350 to 390	550	400	300
Deflection temp., °F - @ 264 psi fiber stress	-	-	-	195
@ 66 psi fiber stress	258	250	-	300

Volume resistivity, ohm-cm.	1.2x10 ¹⁸	> 10 ¹⁸	> 2x10 ¹⁸	2x10 ¹⁴
Dielectric strength (short time) volts/mil	500 to 600	480	500 to 600	260
(step-by-step) volts/mil	450 to 550	430	-	-
Dielectric constant, 60 cycles	2.24 to 2.8	2.1	2.1	8.4
10 ³ cycles	2.3 to 2.7	2.1	2.1	8.0
10 ⁶ cycles	2.3 to 2.5	2.1	2.1	6.6
Dissipation (power) factor 60 cycles	0.0012	<0.0002	<0.0003	0.049
10 ³ cycles	0.023 to 0.027	<0.0002	<0.0003	0.018
10 ⁶ cycles	0.009 to 0.017	<0.0002	<0.0003	0.17
Arc resistance, sec.	> 360	> 200	> 165	50 to 70
Water absorption, 24 hr., %	0.00	0.00	0.01	0.04
Burning rate (flammability, in./min.)	none	none	none	self extin- guishing
Effect of sunlight	none	none	none	sl. bleach- ing on long exposures
Effect of weak acids	none	none	none	none
Effect of strong acids	none	none	none	attacked by fuming sulfuric
Effect of weak alkalis	none	none	none	none
Effect of strong alkalis	none	none	none	none
Effect of organic solvents	halogenated cpds. cause sl. swelling	none	none	resists most
Machining qualities	excellent	excellent	excellent	excellent

Melanine-Formaldehyde Molding Compounds

Properties	Ionomers	Filler		
		α-Cellulose	Asbestos	Macer. ted Fabric Filler
Specific gravity (density)	0.93 to 0.95	1.47 to 1.52	1.70 to 2.0	1.5
Specific volume, cu.in/lb.	29.2 to 29.8	18.2 to 18.8	13.8 to 16.3	18.5
Refractive index, n _D	-	-	-	-
Tensile strength, psi	3500-5500	7000-13000	5500-7000	8000-10500
Elongation, %	340 to 450	0.6 to 0.9	0.30 to 0.45	0.6 to 0.8
Tensile modulus, 10 ⁵ psi	0.2 to 0.5	12 to 14	19.5	14 to 16
Compressive strength, psi x10 ⁻³	-	25.0 to 45.0	30.0	30.0 to 35.0
Flexural strength, psi x10 ⁻³	-	10.0 to 16.0	9.0 to 11.0	12.0 to 15.0
Impact strength, ft.-lb./in.	6 to 15	0.24 to 0.35	0.28 to 0.4	0.6 to 1.0
Hardness, Rockwell	600 (shore)	M110 to M125	M110	M120
Thermal conductivity 10 ⁻⁴ cal. / sec./sq. cm., /1°C/cm.)	5.8	7 to 10	13 to 17	10.6
Specific heat, cal./°C per gm.	0.55	0.4	-	-
Thermal expansion, 10 ⁻³ per °C	-	4.0	2.0 to 4.5	2.5 to 2.8
Resistance to heat, °F (continuous)	160 to 212	210	250 to 400	250
Deflection temp., °F				
@ 264 psi fiber stress	-	360 to 370	265	310
@ 66 psi fiber stress	-	-	-	-

Volume resistivity, ohm-cm.	> 10 ¹⁶	10 ¹² to 10 ¹⁴	1.22x10 ¹²	10 ⁹ to 10 ¹⁰
Dielectric strength (short time) volts/mil	900 to 1100	300 to 400	410 to 430	250 to 350
(step-by-step) volts/mil	2.4 to 2.5	250 to 300	280 to 320	200 to 300
Dielectric constant, 60 cycles	-	7.9 to 9.5	6.4 to 10.2	7.6 to 12.6
10 ³ cycles	-	7.8 to 9.2	9.0	7.1 to 7.8
10 ⁶ cycles	-	7.2 to 8.4	6.1 to 6.7	6.5 to 6.9
Dissipation (power) factor 60 cycles	-	0.030 to 0.083	0.07 to 0.17	0.07 to 0.34
10 ³ cycles	-	0.015 to 0.036	0.07	0.03 to 0.05
10 ⁶ cycles	-	0.027 to 0.045	0.041 to 0.050	0.036 to 0.041
Arc resistance, sec.	-	110 to 180	120 to 180	115 to 125
Water absorption, 24 hr., %	0.1 to 1.4	0.1 to 0.6	0.08 to 0.14	0.3 to 0.6
Burning rate (flammability, in./min.)	very slow	self-extinguishing		
Effect of sunlight	requires U.V. stabilizer	slight color change	slight discoloration	
Effect of weak acids	resistant	none	none to slight	none
Effect of strong acids	attacked by oxidizing acids	decomposes	decomposes	decomposes
Effect of weak alkalis	very resistant	none	very slight attack	none
Effect of strong alkalis	very resistant	attacked	slight attack	attacked
Effect of organic solvents	very resistant @ 75°F	none	none	none
Machining qualities	fair	fair	fair	good

PROPERTIES

	Nylons			
	Type 6/6	Type 6	Type 6/10	20 to 40% Glass Filled
Specific gravity (density)	1.13 to 1.15	1.12 to 1.14	1.09	1.3 to 1.52
Specific volume, cu.in./lb.	24.2 to 25.5	24.2 to 24.5	25.5	21.7 to 25.4
Refractive index, n_D	1.53	-	-	-
Tensile strength, psi	9000-12000	7000-14000	8500-8600	14000-35000
Elongation, %	60 to 300	25 to 320	85 to 300	1.5 to 6
Tensile modulus, 10^5 psi	1.75 to 4.1	1.5 to 3.8	1.6 to 2.8	8.6 to 18
Compressive strength, psi $\times 10^{-3}$	6.7 to 12.5	7.2 to 13.0	-	15.0 to 24.0
Flexural strength, psi $\times 10^{-3}$	no break	no break	no break	18.0 to 40.0
Impact strength, ft.-lb/in.	1.0 to 2.0	1.0 to 4.0	1.2	2.5 to 6
Hardness, Rockwell	R108 to R118	R103 to R118	R111	M94 to E75
Thermal conductivity 10^{-4} cal. / sec./sq. cm., /($^{\circ}$ C./cm.)	5.85	5.85	5.16	1.5 to 1.7
Specific heat, cal./ $^{\circ}$ C per gm.	0.4	0.38	0.4	0.3 to 0.35
Thermal expansion, 10^{-3} per $^{\circ}$ C	8	8.3	9	1.2 to 3.2
Resistance to heat, $^{\circ}$ F. (continuous)	180 to 300	175 to 250	-	300 to 400
Deflection temp., $^{\circ}$ F				
@ 264 psi fiber stress	150 to 186	152 to 167	-	498 to 502
@ 66 psi fiber stress	360 to 365	300 to 365	300	507 to 510

Volume resistivity, ohm-cm.	10 ¹⁴ to 10 ¹⁵	10 ¹² to 10 ¹⁵	10 ¹⁴ to 10 ¹⁵	1.53-5.5x 10 ¹⁵
Dielectric strength (short time) volts/mil	385 to 470	440 to 510	-	408 to 503
(step-by-step) volts/mil	340 to 410	320 to 440	-	375 to 450
Dielectric constant, 60 cycles	4.0 to 4.6	3.9 to 5.5	3.9	4.0 to 4.6
10 ³ cycles	3.9 to 4.5	4.0 to 4.9	3.6	3.9 to 4.4
10 ⁶ cycles	3.4 to 3.6	3.5 to 4.7	3.5	3.4 to 3.9
Dissipation (power) factor 60 cycles	0.014 to 0.04	0.010 to 0.06	0.04	0.018 to 0.025
10 ³ cycles	0.02 to 0.04	0.011 to 0.06	0.04	0.020 to 0.025
10 ⁶ cycles	0.04	0.03 to 0.04	0.04	0.017 to 0.022
Arc resistance, sec.	130 to 140	-	-	92 to 148
Water absorption, 24 hr., %	1.5	1.6 to 1.88	0.4	0.2 to 1.1
Burning rate (flammability, in./min.)	self-extinguishing			
Effect of sunlight	discolors slightly			
Effect of weak acids	resistant	resistant	resistant	resistant
Effect of strong acids	attacked	attacked	attacked	attacked
Effect of weak alkalis	none	none	none	none
Effect of strong alkalis	none	none	none	surface only
Effect of organic solvents	- dissolved by phenols and formic acids			
Machining qualities	excellent	excellent	excellent	resistant to most fair

Polyacrylic Ester Molding Material	Phenol-Formaldehyde and Phenol-Furfural Molding Compounds		
	No Filler	Cotton Flock Filler	Asbestos Filler
1.3 to 1.5	1.25 to 1.30	1.32 to 1.45	1.45 to 1.9
18.5 to 21.3	21.3 to 22.2	17.8 to 20.9	11.9 to 20.9
-	1.5 to 1.7	-	-
1200-2000	7000-8000	6500-10000	5500-7500
300 to 600	1.0 to 1.5	0.4 to 0.8	0.18 to 0.50
0.002 to 0.004	7.5 to 10	8 to 17	10 to 30
-	10.0 to 30.0	22.0 to 36.0	20.0 to 35.0
-	12.0 to 15.0	8.5 to 12.0	8.3 to 14.0
-	0.20 to 0.36	0.24 to 0.60	0.27 to 3.5
40 to 90(Shore)	M124 to M128	M96 to M120	M95 to M115
-	3 to 6	4 to 7	8 to 22
-	0.38 to 0.42	0.35 to 0.40	0.28 to 0.32
-	2.5 to 6.0	3.0 to 4.5	0.8 to 4
250 to 350	250	350 to 360	350 to 500
-	240 to 260	260 to 340	300 to 400
-	-	-	-

PROPERTIES

Specific gravity (density)

Specific volume, cu.in./lb.

Refractive index, n_D

Tensile strength, psi

Elongation, %

Tensile modulus, 10^5 psi

Compressive strength, psi $\times 10^{-3}$

Flexural strength, psi $\times 10^{-3}$

Impact strength, ft.-lb/in.

Hardness, Rockwell

Thermal conductivity 10^{-4} cal. /
sec./sq. cm., /($^{\circ}\text{C}.$ /cm.)

Specific heat, cal. / $^{\circ}\text{C}$ per gm.

Thermal expansion, 10^{-3} per $^{\circ}\text{C}$

Resistance to heat, $^{\circ}\text{F}.$ (continuous)

Deflection temp., $^{\circ}\text{F}$
@ 264 psi fiber stress

@ 66 psi fiber stress

Volume resistivity, ohm-cm.	2x10 ¹¹ at 70°C	10 ¹²	10 ⁹ to 10 ¹³	10 ¹⁰ to 10 ¹³
Dielectric strength (short time) volts/mil	400 to 700 at 70°C	300 to 400	200 to 400	200 to 350
(step-by-step) volts/mil	-	250 to 350	100 to 375	150 to 300
Dielectric constant, 60 cycles	4 at 70°C	5 to 6.5	5.0 to 13	7.5 to 50
10 ³ cycles	-	4.5 to 6.0	4.4 to 9.0	6 to 30
10 ⁶ cycles	11	4.5 to 5.0	4.0 to 6.0	5.0 to 10.0
Dissipation (power) factor 60 cycles	2 at 70°C	0.06 to 0.10	0.05 to 0.30	0.1 to 0.3
10 ³ cycles	-	0.03 to 0.08	0.04 to 0.20	0.1 to 0.4
10 ⁶ cycles	-	0.015 to 0.03	0.03 to 0.07	0.4 to 0.8
Arc resistance, sec.	-	tracks	tracks	120 to 200
Water absorption, 24 hr., %	-	0.1 to 0.2	0.3 to 0.7	0.10 to 0.5
Burning rate (flammability, in./min.)	fast	very low	very low	none
Effect of sunlight	none	surface darkens	general darkening	general darkening
Effect of weak acids	swells	none to slight	none to slight	none to slight
Effect of strong acids	swells	— decomposed by oxidizing acids	—	—
Effect of weak alkalis	swells	slight	— slight to marked	—
Effect of strong alkalis	swells	decomposes	attacked	attacked
Effect of organic solvents	attacked by some	fairly resistant	fairly resistant	fairly resistant
Machining qualities	-	fair to good	fair to good	good to poor

Phenol-Formaldehyde and Phenol-Furfural
Molding Compounds

PROPERTIES

	Mica Filler	Glass Fiber Filler	Macerated Fabric and Cord Filler	Pulp Pre-formed and Molding Board
Specific gravity (density)	1.65 to 1.92	1.69 to 1.95	1.36 to 1.43	1.36 to 1.42
Specific volume, cu.in/lb.	14.3 to 15.8	14.1 to 15.8	19.4 to 20.4	19.6 to 20.4
Refractive index, n_D	-	-	-	-
Tensile strength, psi	6500-7000	5000-18000	3300-9000	4300-12000
Elongation, %	0.13 to 0.5	0.2	0.37 to 0.57	0.3 to 0.7
Tensile modulus, 10^5 psi	30 to 50	33	9 to 13	9 to 13
Compressive strength, psi $\times 10^{-3}$	25.0 to 30.0	17.0 to 70.0	15.0 to 30.0	16.0 to 35.0
Flexural strength, psi $\times 10^{-3}$	8.0 to 12.0	10.0 to 1.0	8.5 to 15.0	7.0 to 18.5
Impact strength, ft.-lb/in.	0.30 to 0.38	0.3 to 18	0.75 to 8.0	0.5 to 4.5
Hardness, Rockwell	M100 to M110	M95 to M100	M95 to M120	E60 to E85
Thermal conductivity 10^{-4} cal. / sec./sq. cm., / $1^\circ\text{C}/\text{cm.}$)	10 to 14	9 to 14.5	4 to 9	4 to 7
Specific heat, cal./ $^\circ\text{C}$ per gm.	0.28 to 0.32	-	0.30 to 0.35	0.34 to 0.36
Thermal expansion, 10^{-3} per $^\circ\text{C}$	1.9 to 2.6	0.8 to 1.6	1 to 4	3.0 to 4.5
Resistance to heat, $^\circ\text{F.}$ (continuous)	250 to 300	350 to 550	220 to 250	300 to 400
Deflection temp., $^\circ\text{F}$ @ 264 psi fiber stress @ 66 psi fiber stress	300 to 350	300 to 600	250 to 300	260 to 340

	10^{12} to $>10^{14}$	7×10^{12}	10^{11} to 10^{12}	10^{10} to 10^{13}
Volume resistivity, ohm-cm				
Dielectric strength (short time) volts/mil (step-by-step) volts/mil	350 to 400 250 to 390	140 to 400 120 to 270	200 to 400 150 to 300	250 to 550 200 to 450
Dielectric constant, 60 cycles	4.7 to 6.0	7.1	6.0 to 21	5.0 to 8.0
10 ³ cycles	4.4 to 5.5	6.9	5.0 to 11	5.0 to 8.0
10 ⁶ cycles	4.2 to 5.2	4.6 to 6.6	4.5 to 7.0	4.0 to 7.0
Dissipation (power) factor 60 cycles	0.03 to 0.05	0.05	0.08 to 0.64	0.04 to 0.30
10 ³ cycles	0.03 to 0.04	0.02	0.04 to 0.20	0.02 to 0.20
10 ⁶ cycles	0.005 to 0.01	0.012 to 0.026	0.03 to 0.09	0.03 to 0.7
Arc resistance, sec.	tracks	4 to 190	tracks	2 to 130
Water absorption, 24 hr., %	0.01 to 0.05	0.03 to 1.2	0.4 to 1.75	0.6 to 1.8
Burning rate (flammability, in./min.)	none	none	almost none	very low
Effect of sunlight	—	general darkening	—	—
Effect of weak acids	—	none to slight	—	—
Effect of strong acids	decomposed by oxidizing acids; reducing and organic acids	none to slight effect	—	—
Effect of weak alkalis	—	slight to marked	—	—
Effect of strong alkalis	attacked	attacked	attacked	attacked
Effect of organic solvents	—	fairly resistant	—	—
Machining qualities	poor	-	fair to good	fair to good

Phenol-Formaldehyde and Phenol-Furfural
Compounded with Butadiene-Acrylonitrile
Copolymer

	Woodflour and Cotton Flock Filler	Asbestos Filler	Rag Filler	Phenoxy
	1.24 to 1.35	1.60 to 1.65	1.38 to 1.4	1.17 to 1.18
	20.5 to 22.3	16.8 to 17.3	21.0 to 21.3	23 to 23.6
	-	-	-	1.5978
	4500 to 7000	3500 to 4500	6500 to 7000	8000 to 9500
	0.75 to 2.25	-	-	50 to 100
	4.0 to 6.0	5.0 to 9.0	3.5 to 6.0	3.4 to 3.8
	11.0 to 20.0	10.0 to 20.0	20.0 to 25.0	10.4 to 12.0
	7.0 to 12.0	6.0 to 8.0	9.5 to 10.0	12.0 to 14.0
	0.35 to 1.0	0.30 to 0.40	2.0 to 2.3	2.3 to 12
	M37 to M85	M50	M97	R118 to R123
	5	15	2.16	4.2
	0.33	-	-	0.4
	1.5 to 4.0	4.0	-	5.7 to 6.1
	200	225	200	170
	230 to 260	275	300	175 to 188
	-	-	-	187 to 198

PROPERTIES

Specific gravity (density)	
Specific volume, cu.in/lb.	
Refractive index, n_D	
Tensile strength, psi	
Elongation, %	
Tensile modulus, 10^5 psi	
Compressive strength, psi $\times 10^{-3}$	
Flexural strength, psi $\times 10^{-3}$	
Impact strength, ft.-lb/in.	
Hardness, Rockwell	
Thermal conductivity 10^{-4} cal. / sec./sq. cm., /1($^{\circ}$ C./cm.)	
Specific heat, cal./ $^{\circ}$ C per gm.	
Thermal expansion, 10^{-3} per $^{\circ}$ C	
Resistance to heat, $^{\circ}$ F. (continuous)	
Deflection temp., $^{\circ}$ F	
@ 264 psi fiber stress	
@ 66 psi fiber stress	

Volume resistivity, ohm-cm.	10 ¹⁰ to 10 ¹¹	10 ¹¹	10 ¹¹	10 ¹⁰ to 10 ¹³
Dielectric strength (short time) volts/mil (step-by-step) volts/mil	300 to 325 225 to 300	275 to 350 225 to 300	250 to 325 200 to 250	404 to 520 400 to 490
Dielectric constant, 60 cycles 103 cycles 106 cycles	9 to 15 - 5	15 - 5	11.1 to 21 - 6.5	4.1 4.1 3.8
Dissipation (power) factor 60 cycles 103 cycles 106 cycles	0.14 to 0.50 - 0.08 to 0.10	0.15 - 0.010 to 0.15	0.06 to 0.08 - 0.10 to 0.11	0.0012 0.002 0.03
Arc resistance, sec.	tracks	tracks	tracks	-
Water absorption, 24 hr., %	1 to 2	0.25 to 0.5	0.8 to 2	0.13
Burning rate (flammability, in. /min.)	slow	very slow	slow	slow to self-extinguishing
Effect of sunlight	darkens	darkens	darkens	slight discolor embrittlement
Effect of weak acids	none to slight	none to slight	none to slight	none
Effect of strong acids	decomposed by oxidizing acids, reducing and organic acids none to slight effect			resistant
Effect of weak alkalis	— slight to marked			resistant
Effect of strong alkalis	attacked	attacked	attacked	resistant
Effect of organic solvents	— fairly resistant			soluble in aromatics and chlorinated hydrocarbons
Machining qualities	good	good	good	excellent

PROPERTIES	Phenolic Cost Resins		Polycarbonate	
	No Filler	Mineral Filler	Unfilled	10 to 40% Glass Filled
Specific gravity (density)	1.30 to 1.32	1.68 to 1.70	1.2	1.24 to 1.52
Specific volume, cu.in./lb.	20.9 to 21.3	16.3 to 16.5	23	18.2 to 22.4
Refractive index, n_D	1.58 to 1.66	-	1.586	-
Tensile strength, psi	6000 to 9000	4000 to 9000	8000 to 9500	14000 to 20000
Elongation, %	1.5 to 2.0	-	60 to 100	0.9 to 5.0
Tensile modulus, 10^5 psi	4 to 5	-	3.5	12 to 18.5
Compressive strength, psi $\times 10^{-3}$	12.0 to 15.0	29.0 to 34.0	12.5	16.0 to 19.0
Flexural strength, psi $\times 10^{-3}$	11.0 to 17.0	9.0 to 12.0	13.5	22.5 to 30.0
Impact strength, ft.-lb/in.	0.25 to 0.40	0.35 to 0.50	12 to 16	1.2 to 4
Hardness, Rockwell	M93 to M120	M85 to M120	M70 to R118	M88 to M95
Thermal conductivity 10^{-4} cal. / sec. / sq. cm. / $1(^\circ\text{C.} / \text{cm.})$	3.5	-	4.6	2.5 to 5.2
Specific heat, cal. / $^\circ\text{C}$ per gm.	0.3 to 0.4	-	0.30	-
Thermal expansion, 10^{-3} per $^\circ\text{C}$	6.8	7.5	6.6	1.2 to 3.8
Resistance to heat, $^\circ\text{F.}$ (continuous)	160	160	250	300
Deflection temp., $^\circ\text{F}$				
@ 264 psi fiber stress	165 to 175	150 to 175	265 to 280	295 to 300
@ 66 psi fiber stress	-	-	285	308 to 315

	10^{12} to 10^{13}	10^9 to 10^{12}	2.1×10^{16}	$1.4 - 1.52 \times 10^{15}$
Volume resistivity, ohm-cm				
Dielectric strength (short time) volts/mil (step-by-step) volts/mil	350 to 400 250 to 300	100 to 250 75 to 200	400 364	475 475
Dielectric constant, 60 cycles 10 ³ cycles 10 ⁶ cycles	6.5 to 7.5 5.5 to 6.0 4.0 to 5.5	- 14 to 30 9 to 15	3.17 3.02 2.96	3.7 3.7 3.2 to 3.5
Dissipation (power) factor 60 cycles 10 ³ cycles 10 ⁶ cycles	0.10 to 0.15 0.01 to 0.05 0.04 to 0.05	- 0.10 to 0.30 0.07 to 0.20	0.0009 0.0021 0.010	0.003 to 0.005 0.002 to 0.004 0.009
Arc resistance, sec.	-	-	10 to 120	5 to 120
Water absorption, 24 hr., %	0.3 to 0.4	0.12 to 0.36	0.15	0.07 to 0.10
Burning rate (flammability, in./min.)	very slow	almost none	self-extinguishing	non-burning
Effect of sunlight	colors may fade	darkens	slight color change and embrittlement	none
Effect of weak acids	— none to slight	—	none	none
Effect of strong acids	decomposed by oxidizing acids	attacked by oxidizing acids	attacked slowly	attacked by oxidizing acids
Effect of weak alkalis	slight to marked	nil	limited resistance	limited resistance
Effect of strong alkalis	decomposes	decomposed	attacked	attacked
Effect of organic solvents	attacked by some	attacked by some	soluble in aromatic & chlorinated solvents	soluble in chlorinated hydrocarbons
Machining qualities	excellent	good to fair	excellent	fair to good

Polyester and Alkyd Resins
Glass Reinforced

PROPERTIES	Cost Polyester Rigid	Preformed Chopped Roving	Premix Chopped Glass	Woven Cloth
Specific gravity (density)	1.10 to 1.46	1.35 to 2.3	1.8 to 2.3	1.50 to 2.1
Specific volume, cu.in./lb.	19.0 to 25.2	13.9 to 20.5	-	18.5 to 13.2
Refractive index, n_D	1.523 to 1.57	-	-	-
Tensile strength, psi	6000 to 13000	25000 to 30000	4000 to 10000	30000 to 5000
Elongation, %	<5	0.5 to 5.0	-	0.5 to 2.0
Tensile modulus, 10^5 psi	3.0 to 6.4	8.0 to 20.0	16 to 25	15.0 to 45.0
Compressive strength, psi $\times 10^{-3}$	13.0 to 36.5	15.0 to 30.0	20.0 to 30.0	25.0 to 50.0
Flexural strength, psi $\times 10^{-3}$	8.5 to 23.0	10.0 to 40.0	12.0 to 20.0	40.0 to 80.0
Impact strength, ft.-lb/in.	0.2 to 0.4	2 to 10	1.5 to 16.0	5 to 30
Hardness, Rockwell	M70 to M115	M70 to M120	60 to 80 (Barcol)	M80 to M120
Thermal conductivity 10^{-4} cal. / sec./sq. cm., /1($^{\circ}$ C./cm.)	4	-	10 to 16	-
Specific heat, cal./ $^{\circ}$ C per gm.	-	-	0.25	-
Thermal expansion, 10^{-3} per $^{\circ}$ C	5.5 to 10	2 to 5	2.5 to 3.3	1.5 to 3
Resistance to heat, $^{\circ}$ F. (continuous)	250	300 to 350	300 to 350	300 to 350
Deflection temp., $^{\circ}$ F @ 264 psi fiber stress @ 66 psi fiber stress	140 to 400 - -	- - -	>400 - -	- - -

	10 ¹⁴	10 ¹⁴	10 ¹² to 10 ¹⁵	10 ¹⁴
Volume resistivity, ohm-cm.				
Dielectric strength (short time) volts/mil	380 to 500	350 to 500	345 to 420	350 to 500
(step-by-step) volts/mil	280 to 420	-	275 to 390	-
Dielectric constant, 60 cycles	3.0 to 4.36	3.8 to 6.0	5.3 to 7.3	4.1 to 5.5
10 ³ cycles	2.8 to 5.2	4.0 to 6.0	4.68	4.2 to 6.0
10 ⁶ cycles	2.8 to 4.1	3.5 to 5.5	5.2 to 6.4	4.0 to 5.5
Dissipation (power) factor 60 cycles	0.003 to 0.028	0.01 to 0.04	0.011 to 0.041	0.01 to 0.04
10 ³ cycles	0.005 to 0.025	0.01 to 0.05	-	0.01 to 0.06
10 ⁶ cycles	0.006 to 0.026	0.01 to 0.03	0.008 to 0.022	0.01 to 0.03
Arc resistance, sec.	125	120 to 180	120 to 240	60 to 120
Water absorption, 24 hr., %	0.15 to 0.60	0.01 to 1.0	0.06 to 0.28	0.05 to 0.5
Burning rate (flammability, in./min.)	1.1 to self-extinguishing	slow to self-extinguishing	slow to self-extinguishing	slow to self-extinguishing
Effect of sunlight	yellow slightly	slight	variable	slight
Effect of weak acids	none	slight	slight	slight
Effect of strong acids	none to considerable	attacked	attacked	attacked
Effect of weak alkalis	none to slight	slight to attacked	slight to attacked	attacked
Effect of strong alkalis	attacked	attacked	slight to attacked	attacked
Effect of organic solvents	attacked by ketones and chlorinated solvents	slight	none	slight
Machining qualities	good	good	good	good

Polyester and Alkyd Molding Materials

PROPERTIES

	Granular and Putty Types Mineral Filled	Asbestos Filled	Synthetic Fiber Filled	Polyimides, Aromatic
Specific gravity (density)	1.60 to 2.30	1.65	1.24 to 1.40	1.43
Specific volume, cu. in./lb.	5.4 to 12.3	16.8	22.3	19.3
Refractive index, n_D	-	-	-	-
Tensile strength, psi	3000 to 8000	4500 to 7000	4500 to 6000	10500
Elongation, %	-	-	-	6 to 7
Tensile modulus, 10^5 psi	5 to 26	-	-	4.5
Compressive strength, psi $\times 10^{-3}$	18.0 to 25.0	22.5	20.0 to 30.0	>24.0
Flexural strength, psi $\times 10^{-3}$	6.0 to 10.0	8.0 to 10.0	10.0 to 12.0	-
Impact strength, ft.-lb/in.	0.30 to 0.50	0.45 to 0.50	0.55 to 4.5	1.1
Hardness, Rockwell	60 to 70 (Barcol)	M99	-	H85 to H95
Thermal conductivity 10^{-4} cal. / sec. / sq. cm. / $1^\circ\text{C.} / \text{cm.}$	15 to 25	-	-	-
Specific heat, cal. / $^\circ\text{C}$ per gm.	0.25	-	-	0.27
Thermal expansion, 10^{-3} per $^\circ\text{C}$	3.5 to 5	-	-	4 to 5
Resistance to heat, $^\circ\text{F.}$ (continuous)	300 to 350	450	300 to 430	500
Deflection temp., $^\circ\text{F}$ @ 264 psi fiber stress @ 66 psi fiber stress	350 to 425	315	240 to 290	650

	10^{14}	6.6×10^8	10^8 to 10^{16}	$> 10^{16}$
Volume resistivity, ohm-cm.				
Dielectric strength (short time) volts/mil	350 to 450	380	365 to 400	560
(step-by-step) volts/mil	300 to 350	290	330 to 350	-
Dielectric constant, 60 cycles	5.1 to 7.5	-	3.8	3.4
10 ³ cycles	5.0 to 6.2	5.2	3.7	-
10 ⁶ cycles	4.6 to 5.5	4.5	3.6	-
Dissipation (power) factor 60 cycles	0.009 to 0.06	-	0.026	-
10 ³ cycles	0.01 to 0.03	0.11	0.020 to 0.03	-
10 ⁶ cycles	0.015 to 0.04	0.04 to 0.06	0.01 to 0.016	-
Arc resistance, sec.	75 to 190	138	85 to 115	-
Water absorption, 24 hr., %	0.05 to 0.5	0.14	0.08 to 0.2	-
Burning rate (flammability, in./min.)	slow to non-burning	self-extinguishing	self-extinguishing	-
Effect of sunlight	none	none	none	-
Effect of weak acids	none	none	none	-
Effect of strong acids	attacked	slight	slight	-
Effect of weak alkalis	attacked	none	none	-
Effect of strong alkalis	decomposes	slight	slight	-
Effect of organic solvents	none	none	none	-
Machining qualities	fair	good	excellent	-

PROPERTIES	Poly-Phenylene Oxide	Poly-Sulfone	Polyethylene	
			Low Density	High Density
Specific gravity (density)	1.06	1.24	0.910 to 0.925	0.941 to 0.965
Specific volume, cu.in./lb.	26.1	22.3	30.0 to 30.5	28.8 to 29.6
Refractive index, n_D	-	1.633	1.51	1.54
Tensile strength, psi	11000	10200 (at yield)	1000 to 2300	3100 to 5500
Elongation, %	50 to 80	50 to 100	90 to 800	15 to 100
Tensile modulus, 10^5 psi	3.8	3.6	0.17 to 0.35	0.6 to 1.5
Compressive strength, psi $\times 10^{-3}$	13.0	13.9 (at yield)	-	3.2
Flexural strength, psi $\times 10^{-3}$	15.0	15.4 (at yield)	-	1.0
Impact strength, ft.-lb/in.	1.5 to 1.9	1.2 (1/8" bar, -40°F)	no break	1.5 to 20
Hardness, Rockwell	R118 to R120	M69, R120	D41 to D46 (Shore)	D60 to D70 (Shore)
Thermal conductivity 10^{-4} cal./sec./sq. cm., /1(°C./cm.)	4.5	6.2	8.0	11 to 12.4
Specific heat, cal./°C per gm.	-	0.3	0.55	0.55
Thermal expansion, 10^{-3} per °C	2.7 to 3.1	5.6	16 to 18	11 to 13
Resistance to heat, °F. (continuous)	-	345	180 to 212	250
Deflection temp., °F	375	-	90 to 105	110 to 120
@ 264 psi fiber stress	-	358	100 to 121	140 to 180
@ 66 psi fiber stress	-	-	-	-

Volume resistivity, ohm-cm	10^{17}	5×10^{16}	$> 10^{16}$	$> 10^{16}$
Dielectric strength (short time) volts/mil (step-by-step) volts/mil	400 to 500 -	425 400	460 to 700 420 to 700	450 to 500 440 to 600
Dielectric constant, 60 cycles 103 cycles 106 cycles	2.58 - 2.58	3.14 3.13 3.10	2.25 to 2.35 2.25 to 2.35 2.25 to 2.35	2.30 to 2.35 2.30 to 2.35 2.30 to 2.35
Dissipation (power) factor 60 cycles 103 cycles 106 cycles	0.00035 - 0.0009	0.0008 0.0011 0.0056	<0.0005 <0.0005 <0.0005	<0.0005 <0.0005 <0.0005
Arc resistance, sec.	20 to 75	122	135 to 160	-
Water absorption, 24 hr., %	0.06	0.22	<0.015	<0.01
Burning rate (flammability, in./min.)	— self - extinguishing. —			
Effect of sunlight	-	strength loss	material crazes rapidly but resistant grades available	very slow (1 to 1.04)
Effect of weak acids	none	none	resistant	very resistant
Effect of strong acids	none	none	attacked by oxidizing acids	
Effect of weak alkalies	none	none	resistant	very resistant
Effect of strong alkalies	none	none	resistant	very resistant
Effect of organic solvents	soluble or swells in some	aliphatic-none aromatic- partly soluble	resistant (below 60°C)	resistant (below 80°C)
Machining abilities	excellent	excellent	good	excellent

PROPERTIES

Specific gravity (density)

Specific volume, cu. in./lb.

Refractive index, n_D

Tensile strength, psi

Elongation, %

Tensile modulus, 10^5 psi

Compressive strength, psi $\times 10^{-3}$

Flexural strength, psi $\times 10^{-3}$

Impact strength, ft. -lb/in.

Hardness, Rockwell

Thermal conductivity 10^{-4} cal. /
sec. /sq. cm., /1($^{\circ}$ C. /cm.)

Specific heat, cal. / $^{\circ}$ C per gm.

Thermal expansion, 10^{-3} per $^{\circ}$ C

Resistance to heat, $^{\circ}$ F. (continuous)

Deflection temp., $^{\circ}$ F

@ 264 psi fiber stress

@ 66 psi fiber stress

Polyethylene			Polypropylene	
Ethylene Ethyl Acrylate Copolymer	Ethylene- Vinyl Acetate Copolymer	High Molecular Weight	Unmodified	
0.93	0.92 to 0.95	0.94	0.902 to 0.906	
-	-	29.8	30.4 to 30.8	
-	-	-	1.49	
800 to 2000	1400 to 3800	5400	4300 to 5500	
300 to 700	650 to 900	525	200 to 700	
0.046 to 0.067	0.02 to 0.07	1.02	1.6 to 2.25	
-	-	-	5.5 to 8.0	
3.0 to 3.6	-	-	6.0 to 8.0	
no break	no break	no break	0.5 to 1.5 @ 73 $^{\circ}$ F	
D27 to D36 (Shore)	D30 to D95 (Shore)	55	R85 to R110	
-	-	-	2.8	
0.55	0.55	-	0.46	
16.23	16 to 20	7.2	5.8 to 10.2	
190 to 200	-	-	250 to 320	
-	-	-	135 to 145	
-	140 to 147	163	205 to 230	

Volume resistivity, ohm-cm.	2.4×10^9	1.5×10^8	$> 10^{16}$	$> 10^{16}$
Dielectric strength (short time) volts/mil (step-by-step) volts/mil	450 to 550 -	450 to 700 450	710 680	500 to 660 450 to 650
Dielectric constant, 60 cycles	2.7 to 2.9	2.5 to 3.16	-	2.2 to 2.6
10 ³ cycles	2.7 to 2.9	2.6 to 2.98	-	2.2 to 2.6
10 ⁶ cycles	2.7 to 2.8	2.6 to 2.8	2.30	2.2 to 2.6
Dissipation (power) factor 60 cycles	0.01 to 0.02	0.003 to 0.02	-	< 0.0005
10 ³ cycles	0.01 to 0.02	0.003 to 0.02	-	< 0.0005 to 0.0018
10 ⁶ cycles	0.01 to 0.02	0.03 to 0.04	0.0002	< 0.005 to 0.0018
Arc resistance, sec.	-	-	-	185
Water absorption, 24 hr., %	0.04	0.03 to 0.05	< 0.01	0.03
Burning rate (flammability, in./min.)	very slow	very slow	very slow	slow
Effect of sunlight	---- very slight yellowing --	-	-	crazes rapidly resistant grades available
Effect of weak acids	resistant	resistant	-	none
Effect of strong acids	attacked by oxidizing acids	attacked	-	attacked slowly by oxidizing acids
Effect of weak alkalis	resistant	resistant	-	none
Effect of strong alkalis	resistant	resistant	-	very resistant
Effect of organic solvents	soluble in aromatic attacked in chlorinated	solvents over 50°C soluble in chlorinated	-	resistant below 80°C
Machining qualities	fair	fair	-	good

Polystyrene

PROPERTIES	Polystyrene			Special Heat and Chemical Resistant Type	Styrene-Acrylonitrile Copolymer Unfilled
	Unfilled General-Purpose	Impact-resistant Medium-impact High-impact			
Specific gravity (density)	1.04 to 1.09	0.98 to 1.10		1.05 to 1.11	1.075 to 1.10
Specific volume, cu.in./lb.	26.0 to 26.4	25.2 to 28.1		24.8 to 26.2	25.2 to 25.8
Refractive index, n_D	1.59 to 1.60			1.57 to 1.60	1.56 to 1.57
Tensile strength, psi	5000 to 12000	3000 to 6800		6500 to 12000	9500 to 12000
Elongation, %	1.0 to 2.5	5 to 8.0		1.4 to 2.5	1.5 to 3.5
Tensile modulus, 10^5 psi	4 to 6	2 to 4.5		4 to 6	4 to 5.6
Compressive strength, psi $\times 10^{-3}$	11.5 to 16.0	4.0 to 9.0		11.5 to 16.0	14.0 to 17.0
Flexural strength, psi $\times 10^{-3}$	8.7 to 14.0	5.0 to 10.0		10.0 to 17.0	14.0 to 19.0
Impact strength, ft.-lb/in.	0.25 to 0.40 1/4" bar	0.5 to 11.0		0.35 to 0.60 1/4" bar	0.35 to 0.50
Hardness, Rockwell	M65 to M80	M35 to M70		M65 to M90	M80 to M90
Thermal conductivity 10^{-4} cal. / sec. / sq. cm. / $1(^{\circ}\text{C.} / \text{cm.})$	2.4 to 3.3	1.0 to 3.0		1.9 to 3.0	2.9
Specific heat, cal. / $^{\circ}\text{C}$ per gm.	0.32	0.32 to 0.35		0.32 to 0.35	0.32 to 0.34
Thermal expansion, 10^{-3} per $^{\circ}\text{C}$	6 to 8	3.4 to 21		6 to 8	3.6 to 8
Resistance to heat, $^{\circ}\text{F.}$ (continuous)	150 to 170	140 to 175		170 to 200	140 to 205
Deflection temp., $^{\circ}\text{F}$ @ 264 psi fiber stress @ 66 psi fiber stress	205 max.	205 max.		180 to 235	190 to 215

Volume resistivity, ohm-cm.	$> 10^{16}$	$> 10^{16}$	10^{13} to 10^{17}	$> 10^{16}$
Dielectric strength (short time) volts/mil (step-by-step) volts/mil	500 to 700 400 to 600	300 to 600 300 to 600	400 to 600 300 to 500	400 to 500 300 to 600
Dielectric constant, 60 cycles	2.45 to 2.65	2.45 to 4.75	2.45 to 3.4	2.6 to 3.4
10 ³ cycles	2.4 to 2.65	2.4 to 4.5	2.4 to 3.2	2.5
10 ⁶ cycles	2.4 to 2.65	2.4 to 3.8	2.4 to 3.1	2.75 to 3.1
Dissipation (power) factor 60 cycles	10^{-4} to 3×10^{-4}	4×10^{-4} to 2×10^{-3}	5×10^{-4} to 3×10^{-3}	4×10^{-3} to 10^{-2}
10 ³ cycles	10^{-4} to 3×10^{-4}	4×10^{-4} to 2×10^{-3}	5×10^{-4} to 3×10^{-3}	7×10^{-3} to 10^{-2}
10 ⁶ cycles	10^{-4} to 4×10^{-4}	4×10^{-4} to 2×10^{-3}	5×10^{-4} to 5×10^{-3}	7×10^{-3} to 10^{-2}
Arc resistance, sec.	60 to 80	20 to 100	60 to 135	100 to 150
Water absorption, 24 hr., %	0.03 to 0.10	0.05 to 0.6	0.05 to 0.40	0.20 to 0.30
Burning rate (flammability, in./min.)	slow	slow	slow	slow
Effect of sunlight	yellowish slightly	strength loss	— yellowish slightly	—
Effect of weak acids	none	none	none	none
Effect of strong acids	—	attacked by oxidizing acids	—	—
Effect of weak alkalis	none	none	none	none
Effect of strong alkalis	none	none	none	none
Effect of organic solvents	soluble in aromatic and chlorinated hydrocarbons			
Machining qualities	fair to good	good	fair to good	good

PROPERTIES	Silicones	Urea-Form- Aldehyde	Urethanes	
			Cast	Urethane
	Cast Resin	α -Cellulose	Liquid	Elastomer
	Flexible	Filler	Urethane	Texin
Specific gravity (density)	1.05 to 1.23	1.47 to 1.52	1.2 to 2.5	1.24 to 1.26
Specific volume, cu. in./lb	-	18.2 to 18.8	21 to 23	22.0 to 22.3
Refractive index, n_D	1.43	1.54 to 1.56	-	-
Tensile strength, psi	800 to 1000	5500 to 13000	175 to 10000	5000 to 8000
Elongation, %	100	0.5 to 1.0	100 to 1000	100 to 600
Tensile modulus, 10^5 psi	900	10 to 15	80	0.1
Compressive strength, psi $\times 10^{-3}$	0.10	25.0 to 45.0	20.0	20.0
Flexural strength, psi $\times 10^{-3}$	-	10.0 to 18.0	-	0.7 to 1.0
Impact strength, ft.-lb/in.	-	0.25 to 0.40	does not break	
Hardness, Rockwell	40-45 (Shore A)	M110 to M120	M28 to R60	M28 to R60
Thermal conductivity 10^{-4} cal. / sec. / sq. cm. , / $1^\circ\text{C.} / \text{cm.}$)	3.5 to 7.5	7 to 10	5	5
Specific heat, cal. / $^\circ\text{C}$ per gm.	-	0.4	0.42 to 0.44	0.42 to 0.44
Thermal expansion, 10^{-3} per $^\circ\text{C}$	25 to 30	2.2 to 3.6	10 to 20	10 to 20
Resistance to heat, $^\circ\text{F.}$ (Continuous)	400	170	190 to 250	190
Deflection temp., $^\circ\text{F}$	-	260 to 290	-	-
@ 264 psi fiber stress	-	-	-	-
@ 66 psi fiber stress	-	-	-	-

Volume resistivity, ohm-cm.	2×10^{15}	10^{12} to 10^{13}	2×10^{11} to 10^{15}	2×10^{11}
Dielectric strength (short time) volts/mil (step-by-step) volts/mil	550 550	300 to 400 220 to 300	450 to 500 450 to 500	450 to 500 450 to 500
Dielectric constant, 60 cycles	2.75 to 3.05	7.0 to 9.5	4 to 7.5	6.7 to 7.5
103 cycles	-	7.0 to 7.5	4 to 7.5	6.7 to 7.5
106 cycles	2.6 to 2.7	6 to 8	6.5 to 7.1	6.5 to 7.1
Dissipation (power) factor 60 cycles	0.007 to 0.001	0.035 to 0.043	0.015 to 0.017	0.015 to 0.017
103 cycles	-	0.025 to 0.035	0.050 to 0.060	0.050 to 0.060
106 cycles	0.001 to 0.002	0.25 to 0.35	-	-
Arc resistance, sec.	115 to 130	80 to 150	0.1 to 0.6	-
Water absorption, 24 hr., %	0.12 (7 days 77°F)	0.4 to 0.8	-	-
Burning rate (flammability, in./min.)	— self-extinguishing —			
Effect of sunlight	none	pastels grey	slow	slow
Effect of weak acids	little or none	none to slight	none to yellow	none
Effect of strong acids	slight to severe	decomposes	slight	dissolves
Effect of weak alkalis	little or none	slight to marked	attacked (moderate)	dissolves
Effect of strong alkalis	moderate to severe	decomposes	attacked (moderate)	dissolves
Effect of organic solvents	attacked by some	none to slight	none to slight	resists most
Machining qualities	-	fair	excellent	fair to excellent

VINYL POLYMERS AND COPOLYMERS

PROPERTIES	Vinyl Butyral Molding Com- pounds Flexible Unfilled	Vinyl Chloride and Vinyl Chloride- Acetate	Vinylidene Chloride Molding Compounds	Polyvinyl Dichloride Compound
Specific gravity (density)	1.05	1.16 to 1.35	1.65 to 1.72	1.50 to 1.55
Specific volume, cu. in./lb.	26.2	20.5 to 23.8	16.1 to 16.8	17.8 to 18.4
Refractive index, n_D	1.47 to 1.49	-	1.60 to 1.63	-
Tensile strength, psi	500 to 3000	1500 to 3500	3000 to 5000	7500 to 9000
Elongation, %	150 to 450	200 to 450	up to 250	4.5
Tensile modulus, 10^5 psi	-	-	0.5 to 0.8	$4-4.5 \times 10^5$
Compressive strength, psi $\times 10^{-3}$	-	0.9 to 1.7	2.0 to 2.7	9.0 to 14.0
Flexural strength, psi $\times 10^{-3}$	varies	-	4.2 to 6.2	14.5 to 17.0
Impact strength, ft.-lb/in.	varies	varies	0.3 to 1.0	2.5 to 5.5
Hardness, Rockwell	10 to 100 (Shore)	-	M50 to M65	117
Thermal conductivity 10^{-4} cal. / sec. / sq. cm., / $1(^{\circ}\text{C.} / \text{cm.})$	-	3.0 to 4.0	3.0	3.3×10^{-4}
Specific heat, cal. / $^{\circ}\text{C}$ per gm.	-	0.3 to 0.5	0.32	3.3×10^{-4}
Thermal expansion, 10^{-3} per $^{\circ}\text{C}$	-	7 to 25	19	7
Resistance to heat, $^{\circ}\text{F.}$ (continuous)	-	150 to 175	160 to 200	210
Deflection temp., $^{\circ}\text{F}$	-	-	130 to 150	215 to 220
@ 264 psi fiber stress	-	-	-	247
@ 66 psi fiber stress	-	-	-	-

Volume resistivity, ohm-cm.	5×10^{10}	10^{11} to 10^{15}	10^{14} to 10^{16}	$7-18 \times 10^{15}$
Dielectric strength (short time) volts/mil (step-by-step) volts/mil	350 325	300 to 1000 275 to 900	400 to 600 400 to 600	1220 -
Dielectric constant, 60 cycles 10 ³ cycles 10 ⁶ cycles	5.60 5.10 3.92	5.0 to 9.0 4.0 to 8.0 3.3 to 4.5	4.5 to 6.0 3.5 to 5.0 3.0 to 4.0	3.08 - -
Dissipation (power) factor 60 cycles	0.115	0.08 to 0.15	0.03 to 0.045	0.01887 - 0.02080
10 ³ cycles 10 ⁶ cycles	0.057 0.061	0.07 to 0.16 0.04 to 0.14	0.06 to 0.075 0.05 to 0.08	- -
Arc resistance, sec.	-	-	-	-
Water absorption, 24 hr., %	1.0 to 2.0	0.15 to 0.75	0.1	0.15
Burning rate (flammability, in. /min.)	slow	self - extinguishing		
Effect of sunlight	slight	slight	slight	-
Effect of weak acids	slight	none	none	none
Effect of strong acids	slight	none to slight	resistant	none
Effect of weak alkalis	slight	none	resistant	none
Effect of strong alkalis	slight	none	resistant	none
Effect of organic solvents	soluble or swells in ketones and esters and aromatic hydro- carbons		none to slight	resists most
Machining qualities	-	-	good	excellent

TABLE 11
PHYSICAL PROPERTIES OF PLASTICS USED PRIMARILY AS FILMS
NOT LISTED IN TABLE 10

From Reference 243:

Physical Properties of Plastics Used Primarily as Films not Listed in Table 10

PROPERTIES

	Ethyl Cellulose	Polyester PE Terephthalate	Poly- Urethane Elastomer	Polyvinyl Fluoride
Specific gravity (density)	1.15	1.38 to 1.395	1.19 to 1.20	1.38
Tensile strength, psi	8000 to 10000	25000 40000 (Type T)	5000 to 9000	7000 to 18000
Elongation, %	20 to 30	100; 50 (Type T)	50 to 100	115 to 250
Resistance to heat, °F. (continuous)	250	300	190	220 to 250
Volume resistivity, ohm-cm.	10 ¹⁵	10 ¹⁸	2.0 x 10 ¹¹	3 x 10 ¹³
Dielectric strength volts/mil	1500 (10-mil)	7000 (1-mil)	450 to 500	4100
Dielectric constant, 10 ³ cycles 10 ⁶ cycles	3.1 3.0	3.1 3.0	6.7 to 7.5 6.5 to 7.1	8.5 -
Dissipation (power) Factor 10 ³ cycles 10 ⁶ cycles	0.002 to 0.020 0.010 to 0.060	0.0047 0.016	0.050 to 0.060 -	1.6 -
Water absorption, 24 hr., %	2.5 to 7.5	0.8	0.55 to 0.77	< 0.5
Burning rate (flammability, in./min.)	slow burning	slow to self-extinguishing	slow burning	slow to self-extinguishing
Resistance to sunlight	good to fair	medium to excellent	fair to excellent	excellent
Resistance to strong acids	fair to poor	good	poor	excellent
Resistance to strong alkalis	excellent	good	poor	excellent
Resistance to organic solvents	poor	excellent	good	excellent

PROPERTIES

	Vinyl Chloride-Acetate Copolymers		Regenerated Cellulose (Cellophane)	Rubber Hydro- Chloride
	Rigid	Nonrigid		
Specific gravity (density)	1.30 to 1.59	1.20 to 1.45	1.40 to 1.50	1.11
Tensile strength, psi	5500 to 8000	1400	7000 to 18000	3500 to 5000
Elongation, %	2 to 10	150 to 500	10 to 50	200 to 800
Resistance to heat, °F. (continuous)	fair	150 to 200	300	180 to 205
Volume resistivity, ohm-cm.	10 ¹⁶	10 ¹¹ to 10 ¹⁴	10 ¹¹	10 ¹³
Dielectric strength volts/mil	425 to 1300	250 to 1000	2000 to 2500	-
Dielectric constant, 10 ³ cycles 10 ⁶ cycles	3.0 to 3.3 2.8 to 3.1	4.0 to 8.0 3.3 to 4.5	3.2 -	3 3
Dissipation (power) factor 10 ³ cycles 10 ⁶ cycles	0.009 to 0.017 0.006 to 0.019	0.070 to 0.160 0.04 to 0.140	0.015 -	- 0.006
Water absorption, 24 hr., %	negligible	negligible	45 to 115	5
Burning rate (flammability, in. /min.)	— slow to self-extinguishing —		slow	self-extinguishing
Resistance to sunlight	good	good	good	fair
Resistance to strong acids	excellent	good	poor	good
Resistance to strong alkalis	excellent	good	poor	good
Resistance to organic solvents	poor to good	poor to good	-	good

A.S.T.M. Test Methods for Physical Properties Appearing in Table

Specific gravity (density)	D 792
Specific Volume, cu. in/lb.	D 792
Refractive index, n_D	D 542
Tensile strength, psi	D 638 D 651
Elongation, %	D 638
Tensile modulus, 10^5 psi	D 638
Compressive strength, psi	D 695
Flexural strength, psi	D 790
Impact strength, ft. lb/in of notch (1/2 x 1/2 on. notched bar)	D 256
Hardness, Rockwell	D 785
Flexural modulus	D 790
Compressive modulus	D 695
Thermal conductivity, 10^{-4} cal./sec./ sq.cm., /1(°C./cm.)	C 177
Thermal expansion, 10^{-3} per °C.	D 696
Deflection temp., °F 264 & 66 psi fiber stress	D 648
Volume resistivity, ohm-cm. (50% RH and 23°C.)	D 257
Dielectric strength, short time, 1/8-in. thickness, volts/mil	D 149
Dielectric strength, step-by-step, 1/8-in. thickness, volts/mil	D 149
Dielectric constant, 60 cycles	D 150
Dielectric constant, 10^3 cycles	D 150
Dielectric constant, 10^6 cycles	D 150

Dissipation (power) factor, 60 cycles	D 150
10 ³ cycles	D 150
10 ⁶ cycles	D 150
Arc resistance, sec.	D 495
Water absorption, 24 hr., 1/8-in. thickness, %	D 570
Burning rate (or flammability, in. /min.)	D 635
Effect of weak acids	D 543
Effect of strong acids	D 543
Effect of weak alkalies	D 543
Effect of strong alkalies	D 543
Effect of organic solvents	D 543

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A comprehensive list of organic semiconductors has been prepared to include compounds having resistivities in the range 10^{-3} to 10^{20} ohm cm. Where electrical and mechanical properties were found, they were included. Five classes of compounds were reviewed and ten compounds were suggested as displaying electrical hysteresis effects due to mechanical loading. Included in the tables is a listing of physical properties of commercially available plastics.		

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